

## Single-Channel, 128-/256-Position, I<sup>2</sup>C/SPI, Nonvolatile Digital Potentiometer

### FEATURES

- ▶ 10 kΩ and 100 kΩ resistance options
- ▶ Resistor tolerance: 8% maximum
- ▶ Wiper current: ±6 mA
- ▶ Low temperature coefficient: 35 ppm/°C
- ▶ Wide bandwidth: 3 MHz
- ▶ Fast start-up time < 75 μs
- ▶ Linear gain setting mode
- ▶ Single- and dual-supply operation
- ▶ Independent logic supply: 1.8 V to 5.5 V
- ▶ Wide operating temperature: -40°C to +125°C
- ▶ 3 mm × 3 mm LFCSP
- ▶ Qualified for automotive applications

### APPLICATIONS

- ▶ Portable electronics level adjustment
- ▶ LCD panel brightness and contrast controls
- ▶ Programmable filters, delays, and time constants
- ▶ Programmable power supplies

### GENERAL DESCRIPTION

The AD5121/AD5141 potentiometers provide a nonvolatile solution for 128-/256-position adjustment applications, offering guaranteed low resistor tolerance errors of ±8% and up to ±6 mA current density in the A, B, and W pins.

The low resistor tolerance and low nominal temperature coefficient simplify open-loop applications as well as applications requiring tolerance matching.

The linear gain setting mode allows independent programming of the resistance between the digital potentiometer terminals, through R<sub>AW</sub> and R<sub>WB</sub> string resistors, allowing very accurate resistor matching.

The high bandwidth and low total harmonic distortion (THD) ensure optimal performance for ac signals, making it suitable for filter design.

The low wiper resistance of only 40 Ω at the ends of the resistor array allows for pin-to-pin connection.

The wiper values can be set through an SPI-/I<sup>2</sup>C-compatible digital interface that is also used to read back the wiper register and EEPROM contents.

The AD5121/AD5141 are available in a compact, 16-lead, 3 mm × 3 mm LFCSP. The devices are guaranteed to operate over the extended industrial temperature range of -40°C to +125°C.

### FUNCTIONAL BLOCK DIAGRAM

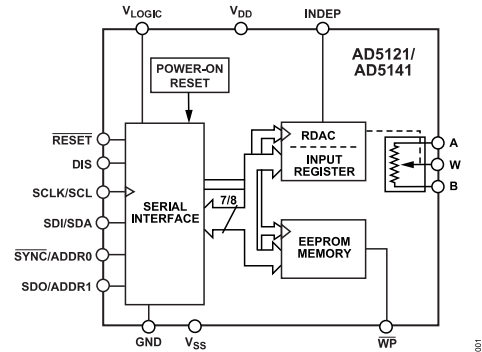


Figure 1.

Table 1. Family Models

Model	Channel	Position	Interface	Package
AD5123 <sup>1</sup>	Quad	128	I <sup>2</sup> C	LFCSP
AD5124	Quad	128	SPI/I <sup>2</sup> C	LFCSP
AD5124	Quad	128	SPI	TSSOP
AD5143	Quad	256	I <sup>2</sup> C	LFCSP
AD5144	Quad	256	SPI/I <sup>2</sup> C	LFCSP
AD5144	Quad	256	SPI	TSSOP
AD5144A	Quad	256	I <sup>2</sup> C	TSSOP
AD5122	Dual	128	SPI	LFCSP/TSSOP
AD5122A	Dual	128	I <sup>2</sup> C	LFCSP/TSSOP
AD5142	Dual	256	SPI	LFCSP/TSSOP
AD5142A	Dual	256	I <sup>2</sup> C	LFCSP/TSSOP
AD5121	Single	128	SPI/I <sup>2</sup> C	LFCSP
AD5141	Single	256	SPI/I <sup>2</sup> C	LFCSP

<sup>1</sup> Two potentiometers and two rheostats.

Rev. D

DOCUMENT FEEDBACK

TECHNICAL SUPPORT

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## REVISION HISTORY

## 5/2022—Rev. C to Rev. D

Changes to Single-Supply Power Range Parameter, Dual-Supply Power Range Parameter, and Logic Supply Range Parameter, Table 2.....	3
Changes to Single-Supply Power Range Parameter, Dual-Supply Power Range Parameter, Logic Supply Range Parameter, and Power Supply Rejection Ratio Parameter, Table 3.....	5
Added Electrostatic Discharge (ESD) Ratings Section.....	11
Added ESD Ratings for AD5121/AD5141 Section and Table 9; Renumbered Sequentially.....	11
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Added Write Operation Section, Figure 42 and Figure 43; Renumbered Sequentially.....	21
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Moved Table 12, Table 13, and Table 14.....	24
Added R <sub>AB</sub> (k $\Omega$ ), Resolution, and Interface Options Section.....	30

## SPECIFICATIONS

## ELECTRICAL CHARACTERISTICS—AD5121

$V_{DD} = 2.3 \text{ V to } 5.5 \text{ V}$ ,  $V_{SS} = 0 \text{ V}$ ;  $V_{DD} = 2.25 \text{ V to } 2.75 \text{ V}$ ,  $V_{SS} = -2.25 \text{ V to } -2.75 \text{ V}$ ;  $V_{LOGIC} = 1.8 \text{ V to } 5.5 \text{ V}$ ,  $-40^\circ\text{C} < T_A < +125^\circ\text{C}$ , unless otherwise noted.

Table 2.

Parameter	Symbol	Test Conditions/Comments	Min	Typ <sup>1</sup>	Max	Unit
DC CHARACTERISTICS—RHEOSTAT MODE (ALL RDACs)						
Resolution	N		7			Bits
Resistor Integral Nonlinearity <sup>2</sup>	R-INL	$R_{AB} = 10 \text{ k}\Omega$ $V_{DD} \geq 2.7 \text{ V}$	-1	$\pm 0.1$	+1	LSB
		$V_{DD} < 2.7 \text{ V}$ $R_{AB} = 100 \text{ k}\Omega$	-2.5	$\pm 1$	+2.5	LSB
Resistor Differential Nonlinearity <sup>2</sup>	R-DNL	$V_{DD} \geq 2.7 \text{ V}$	-0.5	$\pm 0.1$	+0.5	LSB
		$V_{DD} < 2.7 \text{ V}$	-1	$\pm 0.25$	+1	LSB
Nominal Resistor Tolerance	$\Delta R_{AB}/R_{AB}$		-8	$\pm 1$	+8	%
Resistance Temperature Coefficient <sup>3</sup>	$(\Delta R_{AB}/R_{AB})/\Delta T \times 10^6$	Code = full scale		35		ppm/ $^\circ\text{C}$
Wiper Resistance <sup>3</sup>	$R_W$	Code = zero scale $R_{AB} = 10 \text{ k}\Omega$		55	125	$\Omega$
		$R_{AB} = 100 \text{ k}\Omega$		130	400	$\Omega$
Bottom Scale or Top Scale	$R_{BS}$ or $R_{TS}$	$R_{AB} = 10 \text{ k}\Omega$		40	80	$\Omega$
		$R_{AB} = 100 \text{ k}\Omega$		60	230	$\Omega$
DC CHARACTERISTICS—POTENTIOMETER DIVIDER MODE (ALL RDACs)						
Integral Nonlinearity <sup>4</sup>	INL	$R_{AB} = 10 \text{ k}\Omega$	-0.5	$\pm 0.1$	+0.5	LSB
		$R_{AB} = 100 \text{ k}\Omega$	-0.25	$\pm 0.1$	+0.25	LSB
Differential Nonlinearity <sup>4</sup>	DNL		-0.25	$\pm 0.1$	+0.25	LSB
Full-Scale Error	$V_{WFSE}$	$R_{AB} = 10 \text{ k}\Omega$	-1.5	-0.1		LSB
		$R_{AB} = 100 \text{ k}\Omega$	-0.5	$\pm 0.1$	+0.5	LSB
Zero-Scale Error	$V_{WZSE}$	$R_{AB} = 10 \text{ k}\Omega$		1	1.5	LSB
		$R_{AB} = 100 \text{ k}\Omega$		0.25	0.5	LSB
Voltage Divider Temperature Coefficient <sup>3</sup>	$(\Delta V_W/V_W)/\Delta T \times 10^6$	Code = half scale		$\pm 5$		ppm/ $^\circ\text{C}$
RESISTOR TERMINALS						
Maximum Continuous Current	$I_A$ , $I_B$ , and $I_W$	$R_{AB} = 10 \text{ k}\Omega$	-6		+6	mA
		$R_{AB} = 100 \text{ k}\Omega$	-1.5		+1.5	mA
Terminal Voltage Range <sup>5</sup>			$V_{SS}$		$V_{DD}$	V
Capacitance A, Capacitance B <sup>3</sup>	$C_A$ , $C_B$	$f = 1 \text{ MHz}$ , measured to GND, code = half scale $R_{AB} = 10 \text{ k}\Omega$		25		pF
		$R_{AB} = 100 \text{ k}\Omega$		12		pF
Capacitance W <sup>3</sup>	$C_W$	$f = 1 \text{ MHz}$ , measured to GND, code = half scale $R_{AB} = 10 \text{ k}\Omega$		12		pF
		$R_{AB} = 100 \text{ k}\Omega$		5		pF

## SPECIFICATIONS

Table 2.

Parameter	Symbol	Test Conditions/Comments	Min	Typ <sup>1</sup>	Max	Unit
Common-Mode Leakage Current <sup>3</sup>		$V_A = V_W = V_B$	-500	±15	+500	nA
<b>DIGITAL INPUTS</b>						
Input Logic <sup>3</sup>						
High	$V_{INH}$	$V_{LOGIC} = 1.8 \text{ V to } 2.3 \text{ V}$ $V_{LOGIC} = 2.3 \text{ V to } 5.5 \text{ V}$	$0.8 \times V_{LOGIC}$ $0.7 \times V_{LOGIC}$			V V
Low	$V_{INL}$				$0.2 \times V_{LOGIC}$	V
Input Hysteresis <sup>3</sup>	$V_{HYST}$		$0.1 \times V_{LOGIC}$			V
Input Current <sup>3</sup>	$I_{IN}$				±1	μA
Input Capacitance <sup>3</sup>	$C_{IN}$			5		pF
<b>DIGITAL OUTPUTS</b>						
Output High Voltage <sup>3</sup>	$V_{OH}$	$R_{PULL-UP} = 2.2 \text{ k}\Omega \text{ to } V_{LOGIC}$		$V_{LOGIC}$		V
Output Low Voltage <sup>3</sup>	$V_{OL}$	$I_{SINK} = 3 \text{ mA}$ $I_{SINK} = 6 \text{ mA}, V_{LOGIC} > 2.3 \text{ V}$			0.4 0.6	V V
Three-State Leakage Current			-1		+1	μA
Three-State Output Capacitance				2		pF
<b>POWER SUPPLIES</b>						
Single-Supply Power Range	$V_{DD} / V_{SS}$	$V_{SS} = \text{GND}$	2.3		5.5	V
Dual-Supply Power Range	$V_{DD} / V_{SS}$		±2.25		±2.75	V
Logic Supply Range	$V_{LOGIC}$	Single supply, $V_{SS} = \text{GND}$ Dual supply, $V_{SS} < \text{GND}$	1.8 2.25		$V_{DD}$ $V_{DD}$	V V
Positive Supply Current	$I_{DD}$	$V_{IH} = V_{LOGIC}$ or $V_{IL} = \text{GND}$ $V_{DD} = 5.5 \text{ V}$ $V_{DD} = 2.3 \text{ V}$		0.7 400	5.5	μA nA
Negative Supply Current	$I_{SS}$	$V_{IH} = V_{LOGIC}$ or $V_{IL} = \text{GND}$	-5.5	-0.7		μA
EEPROM Store Current <sup>3, 6</sup>	$I_{DD\_EEPROM\_STORE}$	$V_{IH} = V_{LOGIC}$ or $V_{IL} = \text{GND}$		2		mA
EEPROM Read Current <sup>3, 7</sup>	$I_{DD\_EEPROM\_READ}$	$V_{IH} = V_{LOGIC}$ or $V_{IL} = \text{GND}$		320		μA
Logic Supply Current	$I_{LOGIC}$	$V_{IH} = V_{LOGIC}$ or $V_{IL} = \text{GND}$		0.05	1.4	μA
Power Dissipation <sup>8</sup>	$P_{DISS}$	$V_{IH} = V_{LOGIC}$ or $V_{IL} = \text{GND}$		3.5		μW
Power Supply Rejection Ratio	PSRR	$\Delta V_{DD} / \Delta V_{SS} = V_{DD} \pm 10\%$ , code = full scale		-66	-60	dB
<b>DYNAMIC CHARACTERISTICS<sup>9</sup></b>						
Bandwidth	BW	-3 dB $R_{AB} = 10 \text{ k}\Omega$ $R_{AB} = 100 \text{ k}\Omega$		3 0.43		MHz MHz
Total Harmonic Distortion	THD	$V_{DD} / V_{SS} = \pm 2.5 \text{ V}$ , $V_A = 1 \text{ V rms}$ , $V_B = 0 \text{ V}$ , $f = 1 \text{ kHz}$ $R_{AB} = 10 \text{ k}\Omega$ $R_{AB} = 100 \text{ k}\Omega$		-80 -90		dB dB
Resistor Noise Density	$e_{N\_WB}$	Code = half scale, $T_A = 25^\circ\text{C}$ , $f = 10 \text{ kHz}$ $R_{AB} = 10 \text{ k}\Omega$ $R_{AB} = 100 \text{ k}\Omega$		7 20		nV/√Hz nV/√Hz
$V_W$ Settling Time	$t_s$	$V_A = 5 \text{ V}$ , $V_B = 0 \text{ V}$ , from zero scale to full scale, ±0.5 LSB error band $R_{AB} = 10 \text{ k}\Omega$ $R_{AB} = 100 \text{ k}\Omega$		2 12		μs μs
Endurance <sup>10</sup>		$T_A = 25^\circ\text{C}$	100	1		Mcycles kcycles

## SPECIFICATIONS

Table 2.

Parameter	Symbol	Test Conditions/Comments	Min	Typ <sup>1</sup>	Max	Unit
Data Retention <sup>11, 12</sup>				50		Years

<sup>1</sup> Typical values represent average readings at 25°C,  $V_{DD} = 5\text{ V}$ ,  $V_{SS} = 0\text{ V}$ , and  $V_{LOGIC} = 5\text{ V}$ .

<sup>2</sup> Resistor integral nonlinearity (R-INL) error is the deviation from an ideal value measured between the maximum resistance and the minimum resistance wiper positions. R-DNL measures the relative step change from ideal between successive tap positions. The maximum wiper current is limited to  $(0.7 \times V_{DD})/R_{AB}$ .

<sup>3</sup> Guaranteed by design and characterization, not subject to production test.

<sup>4</sup> INL and DNL are measured at  $V_{WB}$  with the RDAC configured as a potentiometer divider similar to a voltage output DAC.  $V_A = V_{DD}$  and  $V_B = 0\text{ V}$ . DNL specification limits of  $\pm 1$  LSB maximum are guaranteed monotonic operating conditions.

<sup>5</sup> Resistor Terminal A, Resistor Terminal B, and Resistor Terminal W have no limitations on polarity with respect to each other. Dual-supply operation enables ground referenced bipolar signal adjustment.

<sup>6</sup> Different from operating current; supply current for EEPROM program lasts approximately 30 ms.

<sup>7</sup> Different from operating current; supply current for EEPROM read lasts approximately 20  $\mu\text{s}$ .

<sup>8</sup>  $P_{DISS}$  is calculated from  $(I_{DD} \times V_{DD}) + (I_{LOGIC} \times V_{LOGIC})$ .

<sup>9</sup> All dynamic characteristics use  $V_{DD}/V_{SS} = \pm 2.5\text{ V}$ , and  $V_{LOGIC} = 2.5\text{ V}$ .

<sup>10</sup> Endurance is qualified to 100,000 cycles per JEDEC Standard 22, Method A117 and measured at  $-40^\circ\text{C}$  to  $+125^\circ\text{C}$ .

<sup>11</sup> Retention lifetime equivalent at junction temperature ( $T_J$ ) =  $125^\circ\text{C}$  per JEDEC Standard 22, Method A117. Retention lifetime, based on an activation energy of 1 eV, derates with junction temperature in the Flash/EE memory.

<sup>12</sup> 50 years applies to an endurance of 1000 cycles. An endurance of 100,000 cycles has an equivalent retention lifetime of 5 years.

## ELECTRICAL CHARACTERISTICS—AD5141

$V_{DD} = 2.3\text{ V}$  to  $5.5\text{ V}$ ,  $V_{SS} = 0\text{ V}$ ;  $V_{DD} = 2.25\text{ V}$  to  $2.75\text{ V}$ ,  $V_{SS} = -2.25\text{ V}$  to  $-2.75\text{ V}$ ;  $V_{LOGIC} = 1.8\text{ V}$  to  $5.5\text{ V}$ ,  $-40^\circ\text{C} < T_A < +125^\circ\text{C}$ , unless otherwise noted.

Table 3.

Parameter	Symbol	Test Conditions/Comments	Min	Typ <sup>1</sup>	Max	Unit
DC CHARACTERISTICS—RHEOSTAT MODE (ALL RDACs)						
Resolution	N		8			Bits
Resistor Integral Nonlinearity <sup>2</sup>	R-INL	$R_{AB} = 10\text{ k}\Omega$				
		$V_{DD} \geq 2.7\text{ V}$	-2	$\pm 0.2$	+2	LSB
		$V_{DD} < 2.7\text{ V}$	-5	$\pm 1.5$	+5	LSB
		$R_{AB} = 100\text{ k}\Omega$				
Resistor Differential Nonlinearity <sup>2</sup>	R-DNL	$V_{DD} \geq 2.7\text{ V}$	-1	$\pm 0.1$	+1	LSB
		$V_{DD} < 2.7\text{ V}$	-2	$\pm 0.5$	+2	LSB
Nominal Resistor Tolerance	$\Delta R_{AB}/R_{AB}$		-8	$\pm 1$	+8	%
Resistance Temperature Coefficient <sup>3</sup>	$(\Delta R_{AB}/R_{AB})/\Delta T \times 10^6$	Code = full scale		35		ppm/°C
Wiper Resistance <sup>3</sup>	$R_W$	Code = zero scale				
		$R_{AB} = 10\text{ k}\Omega$		55	125	$\Omega$
		$R_{AB} = 100\text{ k}\Omega$		130	400	$\Omega$
Bottom Scale or Top Scale	$R_{BS}$ or $R_{TS}$	$R_{AB} = 10\text{ k}\Omega$		40	80	$\Omega$
		$R_{AB} = 100\text{ k}\Omega$		60	230	$\Omega$
DC CHARACTERISTICS—POTENTIOMETER DIVIDER MODE (ALL RDACs)						
Integral Nonlinearity <sup>4</sup>	INL	$R_{AB} = 10\text{ k}\Omega$	-1	$\pm 0.2$	+1	LSB
		$R_{AB} = 100\text{ k}\Omega$	-0.5	$\pm 0.1$	+0.5	LSB

## SPECIFICATIONS

Table 3.

Parameter	Symbol	Test Conditions/Comments	Min	Typ <sup>1</sup>	Max	Unit
Differential Nonlinearity <sup>4</sup>	DNL		-0.5	±0.2	+0.5	LSB
Full-Scale Error	V <sub>WFSE</sub>	R <sub>AB</sub> = 10 kΩ	-2.5	-0.1		LSB
		R <sub>AB</sub> = 100 kΩ	-1	±0.2	+1	LSB
Zero-Scale Error	V <sub>WZSE</sub>	R <sub>AB</sub> = 10 kΩ		1.2	3	LSB
		R <sub>AB</sub> = 100 kΩ		0.5	1	LSB
Voltage Divider Temperature Coefficient <sup>3</sup>	(ΔV <sub>W</sub> /V <sub>W</sub> )/ΔT × 10 <sup>6</sup>	Code = half scale		±5		ppm/°C
<b>RESISTOR TERMINALS</b>						
Maximum Continuous Current	I <sub>A</sub> , I <sub>B</sub> , and I <sub>W</sub>	R <sub>AB</sub> = 10 kΩ	-6		+6	mA
		R <sub>AB</sub> = 100 kΩ	-1.5		+1.5	mA
Terminal Voltage Range <sup>5</sup>			V <sub>SS</sub>		V <sub>DD</sub>	V
Capacitance A, Capacitance B <sup>3</sup>	C <sub>A</sub> , C <sub>B</sub>	f = 1 MHz, measured to GND, code = half scale				
		R <sub>AB</sub> = 10 kΩ		25		pF
		R <sub>AB</sub> = 100 kΩ		12		pF
Capacitance W <sup>3</sup>	C <sub>W</sub>	f = 1 MHz, measured to GND, code = half scale				
		R <sub>AB</sub> = 10 kΩ		12		pF
		R <sub>AB</sub> = 100 kΩ		5		pF
Common-Mode Leakage Current <sup>3</sup>		V <sub>A</sub> = V <sub>W</sub> = V <sub>B</sub>	-500	±15	+500	nA
<b>DIGITAL INPUTS</b>						
Input Logic <sup>3</sup>						
High	V <sub>INH</sub>	V <sub>LOGIC</sub> = 1.8 V to 2.3 V	0.8 × V <sub>LOGIC</sub>			V
		V <sub>LOGIC</sub> = 2.3 V to 5.5 V	0.7 × V <sub>LOGIC</sub>			V
Low	V <sub>INL</sub>				0.2 × V <sub>LOGIC</sub>	V
Input Hysteresis <sup>3</sup>	V <sub>HYST</sub>		0.1 × V <sub>LOGIC</sub>			V
Input Current <sup>3</sup>	I <sub>IN</sub>				±1	μA
Input Capacitance <sup>3</sup>	C <sub>IN</sub>			5		pF
<b>DIGITAL OUTPUTS</b>						
Output High Voltage <sup>3</sup>	V <sub>OH</sub>	R <sub>PULL-UP</sub> = 2.2 kΩ to V <sub>LOGIC</sub>		V <sub>LOGIC</sub>		V
Output Low Voltage <sup>3</sup>	V <sub>OL</sub>	I <sub>SINK</sub> = 3 mA			0.4	V
		I <sub>SINK</sub> = 6 mA, V <sub>LOGIC</sub> > 2.3V			0.6	V
Three-State Leakage Current			-1		+1	μA
Three-State Output Capacitance				2		pF
<b>POWER SUPPLIES</b>						
Single-Supply Power Range	V <sub>DD</sub> / V <sub>SS</sub>	V <sub>SS</sub> = GND	2.3		5.5	V
Dual-Supply Power Range	V <sub>DD</sub> / V <sub>SS</sub>		±2.25		±2.75	V
Logic Supply Range	V <sub>LOGIC</sub>	Single supply, V <sub>SS</sub> = GND	1.8		V <sub>DD</sub>	V
		Dual supply, V <sub>SS</sub> < GND	2.25		V <sub>DD</sub>	V
Positive Supply Current	I <sub>DD</sub>	V <sub>IH</sub> = V <sub>LOGIC</sub> or V <sub>IL</sub> = GND				
		V <sub>DD</sub> = 5.5 V		0.7	5.5	μA
		V <sub>DD</sub> = 2.3 V		400		nA
Negative Supply Current	I <sub>SS</sub>	V <sub>IH</sub> = V <sub>LOGIC</sub> or V <sub>IL</sub> = GND	-5.5	-0.7		μA
EEPROM Store Current <sup>3, 6</sup>	I <sub>DD_EEPROM_STORE</sub>	V <sub>IH</sub> = V <sub>LOGIC</sub> or V <sub>IL</sub> = GND		2		mA
EEPROM Read Current <sup>3, 7</sup>	I <sub>DD_EEPROM_READ</sub>	V <sub>IH</sub> = V <sub>LOGIC</sub> or V <sub>IL</sub> = GND		320		μA
Logic Supply Current	I <sub>LOGIC</sub>	V <sub>IH</sub> = V <sub>LOGIC</sub> or V <sub>IL</sub> = GND		0.05	1.4	μA
Power Dissipation <sup>8</sup>	P <sub>DISS</sub>	V <sub>IH</sub> = V <sub>LOGIC</sub> or V <sub>IL</sub> = GND		3.5		μW

## SPECIFICATIONS

Table 3.

Parameter	Symbol	Test Conditions/Comments	Min	Typ <sup>1</sup>	Max	Unit
Power Supply Rejection Ratio	PSRR	$\Delta V_{DD}/\Delta V_{SS} = V_{DD} \pm 10\%$ , code = full scale		-66	-60	dB
<b>DYNAMIC CHARACTERISTICS<sup>9</sup></b>						
Bandwidth	BW	-3 dB $R_{AB} = 10\text{ k}\Omega$ $R_{AB} = 100\text{ k}\Omega$		3 0.43		MHz MHz
Total Harmonic Distortion	THD	$V_{DD}/V_{SS} = \pm 2.5\text{ V}$ , $V_A = 1\text{ V rms}$ , $V_B = 0\text{ V}$ , $f = 1\text{ kHz}$ $R_{AB} = 10\text{ k}\Omega$ $R_{AB} = 100\text{ k}\Omega$		-80 -90		dB dB
Resistor Noise Density	$e_{N\_WB}$	Code = half scale, $T_A = 25^\circ\text{C}$ , $f = 10\text{ kHz}$ $R_{AB} = 10\text{ k}\Omega$ $R_{AB} = 100\text{ k}\Omega$		7 20		nV/ $\sqrt{\text{Hz}}$ nV/ $\sqrt{\text{Hz}}$
$V_W$ Settling Time	$t_s$	$V_A = 5\text{ V}$ , $V_B = 0\text{ V}$ , from zero scale to full scale, $\pm 0.5\text{ LSB}$ error band $R_{AB} = 10\text{ k}\Omega$ $R_{AB} = 100\text{ k}\Omega$		2 12		$\mu\text{s}$ $\mu\text{s}$
Endurance <sup>10</sup>		$T_A = 25^\circ\text{C}$	100	1		Mcycles kcycles
Data Retention <sup>11, 12</sup>				50		Years

<sup>1</sup> Typical values represent average readings at  $25^\circ\text{C}$ ,  $V_{DD} = 5\text{ V}$ ,  $V_{SS} = 0\text{ V}$ , and  $V_{\text{LOGIC}} = 5\text{ V}$ .

<sup>2</sup> Resistor integral nonlinearity error (R-INL) is the deviation from an ideal value measured between the maximum resistance and the minimum resistance wiper positions. R-DNL measures the relative step change from ideal between successive tap positions. The maximum wiper current is limited to  $(0.7 \times V_{DD})/R_{AB}$ .

<sup>3</sup> Guaranteed by design and characterization, not subject to production test.

<sup>4</sup> INL and DNL are measured at  $V_{WB}$  with the RDAC configured as a potentiometer divider similar to a voltage output DAC.  $V_A = V_{DD}$  and  $V_B = 0\text{ V}$ . DNL specification limits of  $\pm 1\text{ LSB}$  maximum are guaranteed monotonic operating conditions.

<sup>5</sup> Resistor Terminal A, Resistor Terminal B, and Resistor Terminal W have no limitations on polarity with respect to each other. Dual-supply operation enables ground referenced bipolar signal adjustment.

<sup>6</sup> Different from operating current; supply current for EEPROM program lasts approximately 30 ms.

<sup>7</sup> Different from operating current; supply current for EEPROM read lasts approximately 20  $\mu\text{s}$ .

<sup>8</sup>  $P_{\text{DISS}}$  is calculated from  $(I_{DD} \times V_{DD}) + (I_{\text{LOGIC}} \times V_{\text{LOGIC}})$ .

<sup>9</sup> All dynamic characteristics use  $V_{DD}/V_{SS} = \pm 2.5\text{ V}$ , and  $V_{\text{LOGIC}} = 2.5\text{ V}$ .

<sup>10</sup> Endurance is qualified to 100,000 cycles per JEDEC Standard 22, Method A117 and measured at  $-40^\circ\text{C}$  to  $+125^\circ\text{C}$ .

<sup>11</sup> Retention lifetime equivalent at junction temperature ( $T_J$ ) =  $125^\circ\text{C}$  per JEDEC Standard 22, Method A117. Retention lifetime, based on an activation energy of 1 eV, derates with junction temperature in the Flash/EE memory.

<sup>12</sup> 50 years applies to an endurance of 1000 cycles. An endurance of 100,000 cycles has an equivalent retention lifetime of 5 years.

## INTERFACE TIMING SPECIFICATIONS

$V_{\text{LOGIC}} = 1.8\text{ V}$  to  $5.5\text{ V}$ ; all specifications  $T_{\text{MIN}}$  to  $T_{\text{MAX}}$ , unless otherwise noted.

Table 4. SPI Interface

Parameter <sup>1</sup>	Test Conditions/Comments	Min	Typ	Max	Unit	Description
$t_1$	$V_{\text{LOGIC}} > 1.8\text{ V}$	20			ns	SCLK cycle time
	$V_{\text{LOGIC}} = 1.8\text{ V}$	30			ns	
$t_2$	$V_{\text{LOGIC}} > 1.8\text{ V}$	10			ns	SCLK high time
	$V_{\text{LOGIC}} = 1.8\text{ V}$	15			ns	

## SPECIFICATIONS

Table 4. SPI Interface

Parameter <sup>1</sup>	Test Conditions/Comments	Min	Typ	Max	Unit	Description
t <sub>3</sub>	V <sub>LOGIC</sub> > 1.8 V	10			ns	SCLK low time
	V <sub>LOGIC</sub> = 1.8 V	15			ns	
t <sub>4</sub>		10			ns	SYNC-to-SCLK falling edge setup time
t <sub>5</sub>		5			ns	Data setup time
t <sub>6</sub>		5			ns	Data hold time
t <sub>7</sub>		10			ns	SYNC rising edge to next SCLK fall ignored
t <sub>8</sub> <sup>2</sup>		20			ns	Minimum SYNC high time
t <sub>9</sub> <sup>3</sup>			50		ns	SCLK rising edge to SDO valid
t <sub>10</sub>				500	ns	SYNC rising edge to SDO pin disable

<sup>1</sup> All input signals are specified with t<sub>r</sub> = t<sub>f</sub> = 1 ns/V (10% to 90% of V<sub>DD</sub>) and timed from a voltage level of (V<sub>IL</sub> + V<sub>IH</sub>)/2.

<sup>2</sup> Refer to t<sub>EPROGRAM\_PROGRAM</sub> and t<sub>EPROGRAM\_READBACK</sub> for memory commands operations (see Table 6).

<sup>3</sup> R<sub>PULL\_UP</sub> = 2.2 kΩ to V<sub>DD</sub> with a capacitance load of 168 pF.

Table 5. I<sup>2</sup>C Interface

Parameter <sup>1</sup>	Test Conditions/Comments	Min	Typ	Max	Unit	Description
f <sub>SCL</sub> <sup>2</sup>	Standard mode			100	kHz	Serial clock frequency
	Fast mode			400	kHz	
t <sub>1</sub>	Standard mode	4.0			μs	SCL high time, t <sub>HIGH</sub>
	Fast mode	0.6			μs	
t <sub>2</sub>	Standard mode	4.7			μs	SCL low time, t <sub>LOW</sub>
	Fast mode	1.3			μs	
t <sub>3</sub>	Standard mode	250			ns	Data setup time, t <sub>SU; DAT</sub>
	Fast mode	100			ns	
t <sub>4</sub>	Standard mode	0	3.45		μs	Data hold time, t <sub>HD; DAT</sub>
	Fast mode	0	0.9		μs	
t <sub>5</sub>	Standard mode	4.7			μs	Setup time for a repeated start condition, t <sub>SU; STA</sub>
	Fast mode	0.6			μs	
t <sub>6</sub>	Standard mode	4			μs	Hold time (repeated) for a start condition, t <sub>HD; STA</sub>
	Fast mode	0.6			μs	
t <sub>7</sub>	Standard mode	4.7			μs	Bus free time between a stop and a start condition, t <sub>BUF</sub>
	Fast mode	1.3			μs	
t <sub>8</sub>	Standard mode	4			μs	Setup time for a stop condition, t <sub>SU; STO</sub>
	Fast mode	0.6			μs	
t <sub>9</sub>	Standard mode			1000	ns	Rise time of SDA signal, t <sub>RDA</sub>
	Fast mode	20 + 0.1 C <sub>L</sub>		300	ns	
t <sub>10</sub>	Standard mode			300	ns	Fall time of SDA signal, t <sub>FDA</sub>
	Fast mode	20 + 0.1 C <sub>L</sub>		300	ns	
t <sub>11</sub>	Standard mode			1000	ns	Rise time of SCL signal, t <sub>RCL</sub>
	Fast mode	20 + 0.1 C <sub>L</sub>		300	ns	
t <sub>11A</sub>	Standard mode			1000	ns	Rise time of SCL signal after a repeated start condition and after an acknowledge bit, t <sub>RCL1</sub> (not shown in Figure 3)
	Fast mode	20 + 0.1 C <sub>L</sub>		300	ns	
t <sub>12</sub>	Standard mode			300	ns	Fall time of SCL signal, t <sub>FCL</sub>
	Fast mode	20 + 0.1 C <sub>L</sub>		300	ns	
t <sub>SP</sub> <sup>3</sup>	Fast mode	0		50	ns	Pulse width of suppressed spike (not shown in Figure 3)

<sup>1</sup> Maximum bus capacitance is limited to 400 pF.



**SPECIFICATIONS**

**Table 5. I<sup>2</sup>C Interface**

Parameter <sup>1</sup>	Test Conditions/Comments	Min	Typ	Max	Unit	Description
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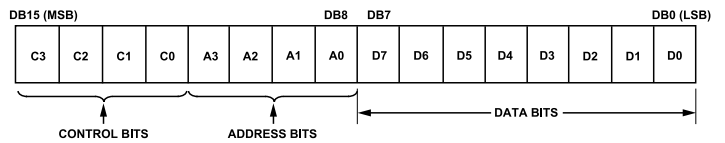
- <sup>2</sup> The SDA and SCL timing is measured with the input filters enabled. Switching off the input filters improves the transfer rate; however, it has a negative effect on the EMC behavior of the part.
- <sup>3</sup> Input filtering on the SCL and SDA inputs suppresses noise spikes that are less than 50 ns for fast mode.

**Table 6. Control Pins**

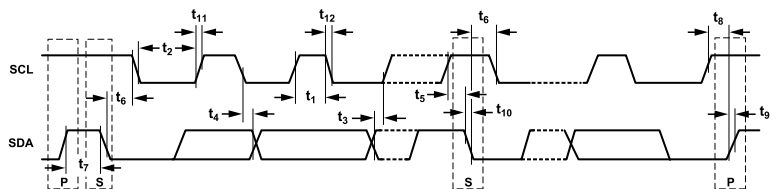
Parameter	Min	Typ	Max	Unit	Description
t <sub>1</sub>	1			μs	End command to $\overline{\text{LRDAC}}$ falling edge
t <sub>2</sub>	50			ns	Minimum $\overline{\text{LRDAC}}$ low time
t <sub>3</sub>	0.1		10	μs	$\overline{\text{RESET}}$ low time
t <sub>E<sup>2</sup>PROM_PROGRAM</sub> <sup>1</sup>		15	50	ms	Memory program time (not shown in Figure 6)
t <sub>E<sup>2</sup>PROM_READBACK</sub>		7	30	μs	Memory readback time (not shown in Figure 6)
t <sub>POWER_UP</sub> <sup>2</sup>			75	μs	Power-on EEPROM restore time (not shown in Figure 6)
t <sub>RESET</sub>		30		μs	Reset EEPROM restore time (not shown in Figure 6)

- <sup>1</sup> EEPROM program time depends on the temperature and EEPROM write cycles. Higher timing is expected at lower temperatures and higher write cycles.
- <sup>2</sup> Maximum time after V<sub>DD</sub> - V<sub>SS</sub> is equal to 2.3 V.

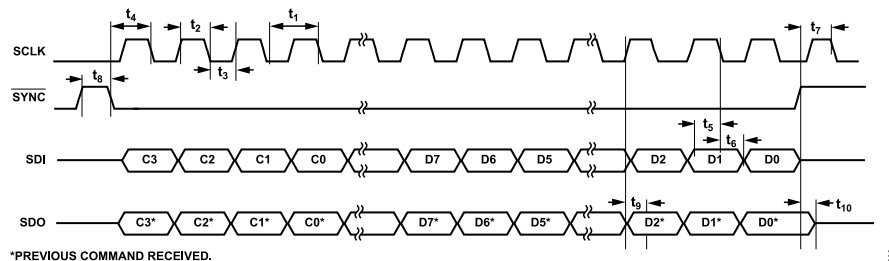
**SHIFT REGISTER AND TIMING DIAGRAMS**



**Figure 2. Input Shift Register Contents**



**Figure 3. I<sup>2</sup>C Serial Interface Timing Diagram (Typical Write Sequence)**



**Figure 4. SPI Serial Interface Timing Diagram, CPOL = 0, CPHA = 1**

SPECIFICATIONS

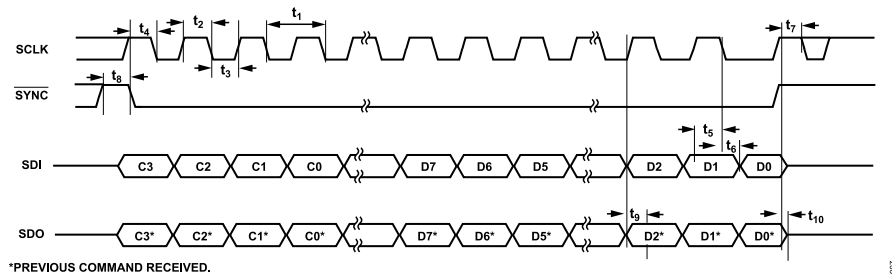


Figure 5. SPI Serial Interface Timing Diagram, CPOL = 1, CPHA = 0

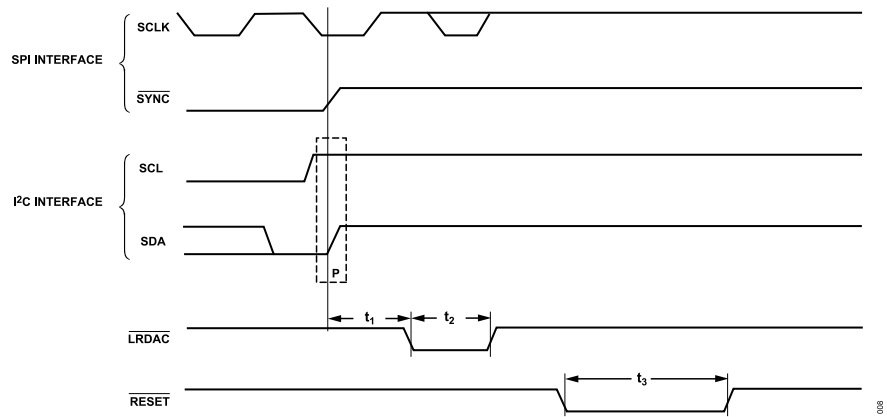


Figure 6. Control Pins Timing Diagram

## ABSOLUTE MAXIMUM RATINGS

$T_A = 25^\circ\text{C}$ , unless otherwise noted.

Table 7.

Parameter	Rating
$V_{DD}$ to GND	-0.3 V to +7.0 V
$V_{SS}$ to GND	+0.3 V to -7.0 V
$V_{DD}$ to $V_{SS}$	7 V
$V_{\text{LOGIC}}$ to GND	-0.3 V to $V_{DD} + 0.3$ V or +7.0 V (whichever is less)
$V_A, V_W, V_B$ to GND	$V_{SS} - 0.3$ V, $V_{DD} + 0.3$ V or +7.0 V (whichever is less)
$I_A, I_W, I_B$ Pulsed <sup>1</sup>	
Frequency > 10 kHz <sup>2</sup>	
$R_{AW} = 10$ k $\Omega$	$\pm 6$ mA/d
$R_{AW} = 100$ k $\Omega$	$\pm 1.5$ mA/d
Frequency $\leq 10$ kHz <sup>2</sup>	
$R_{AW} = 10$ k $\Omega$	$\pm 6$ mA/ $\sqrt{d}$
$R_{AW} = 100$ k $\Omega$	$\pm 1.5$ mA/ $\sqrt{d}$
Digital Inputs	-0.3 V to $V_{\text{LOGIC}} + 0.3$ V or +7 V (whichever is less)
Operating Temperature Range, $T_A$ <sup>3</sup>	-40°C to +125°C
Maximum Junction Temperature, $T_J$ Maximum	150°C
Storage Temperature Range	-65°C to +150°C
Reflow Soldering	
Peak Temperature	260°C
Time at Peak Temperature	20 sec to 40 sec
Package Power Dissipation	$(T_J \text{ max} - T_A)/\theta_{JA}$

<sup>1</sup> Maximum terminal current is bounded by the maximum current handling of the switches, maximum power dissipation of the package, and maximum applied voltage across any two of the A, B, and W terminals at a given resistance.

<sup>2</sup> d = pulse duty factor.

<sup>3</sup> Includes programming of EEPROM memory.

Stresses at or above those listed under Absolute Maximum Ratings may cause permanent damage to the product. This is a stress rating only; functional operation of the product at these or any other conditions above those indicated in the operational section of this specification is not implied. Operation beyond the maximum operating conditions for extended periods may affect product reliability.

## THERMAL RESISTANCE

$\theta_{JA}$  is defined by the JEDEC JESD51 standard, and the value is dependent on the test board and test environment.

Table 8. Thermal Resistance

Package Type	$\theta_{JA}$	$\theta_{JC}$	Unit
16-Lead LFCSP	89.5 <sup>1</sup>	3	°C/W

<sup>1</sup> JEDEC 2S2P test board, still air (0 m/sec airflow).

## ELECTROSTATIC DISCHARGE (ESD) RATINGS

The following ESD information is provided for handling of ESD-sensitive devices in an ESD protected area only.

Human body model (HBM) per ANSI/ESDA/JEDEC JS-001.

Field induced charged device model (FICDM) and charged device model (CDM) per ANSI/ESDA/JEDEC JS-002.

## ESD RATINGS FOR AD5121/AD5141

Table 9. AD5121/AD5141, 16-Lead LFCSP

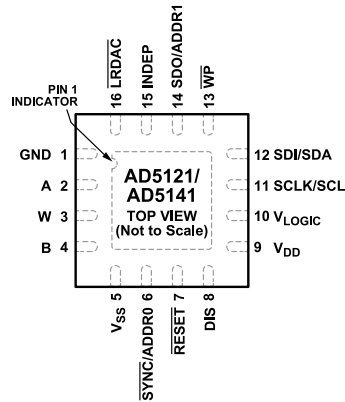
ESD Model	Withstand Threshold (V)	Class
HBM	4000	3A
FICDM	1250	C3

## ESD CAUTION



**ESD (electrostatic discharge) sensitive device.** Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

## PIN CONFIGURATION AND FUNCTION DESCRIPTIONS



NOTES  
 1. EXPOSED PAD. CONNECT THE EXPOSED PAD TO THE POTENTIAL OF THE  $V_{SS}$  PIN, OR, ALTERNATIVELY, LEAVE IT ELECTRICALLY UNCONNECTED. IT IS RECOMMENDED THAT THE PAD BE THERMALLY CONNECTED TO A COPPER PLANE FOR ENHANCED THERMAL PERFORMANCE.

Figure 7. Pin Configuration

Table 10. Pin Function Descriptions

Pin No.	Mnemonic	Description
1	GND	Ground Pin, Logic Ground Reference.
2	A	Terminal A of RDAC. $V_{SS} \leq V_A \leq V_{DD}$ .
3	W	Wiper terminal of RDAC. $V_{SS} \leq V_W \leq V_{DD}$ .
4	B	Terminal B of RDAC. $V_{SS} \leq V_B \leq V_{DD}$ .
5	$V_{SS}$	Negative Power Supply. Decouple this pin with 0.1 $\mu$ F ceramic capacitors and 10 $\mu$ F capacitors.
6	$\overline{\text{SYNC/ADDR0}}$	Programmable Address (ADDR0) for Multiple Package Decoding, DIS = 1. Synchronization Data Input, Active Low. When $\overline{\text{SYNC}}$ returns high, data is loaded into the RDAC register, DIS = 0.
7	$\overline{\text{RESET}}$	Hardware Reset Pin. Refresh the RDAC registers from EEPROM. $\overline{\text{RESET}}$ is activated at logic low. If this pin is not used, tie $\overline{\text{RESET}}$ to $V_{\text{LOGIC}}$ .
8	DIS	Digital Interface Select (SPI/I <sup>2</sup> C Select). This pin cannot be left floating. SPI when DIS = 0 (GND). I <sup>2</sup> C when DIS = 1 ( $V_{\text{LOGIC}}$ ).
9	$V_{DD}$	Positive Power Supply. Decouple this pin with 0.1 $\mu$ F ceramic capacitors and 10 $\mu$ F capacitors.
10	$V_{\text{LOGIC}}$	Logic Power Supply; 1.8 V to $V_{DD}$ . Decouple this pin with 0.1 $\mu$ F ceramic capacitors and 10 $\mu$ F capacitors.
11	SCLK/SCL	SPI Serial Clock Line (SCLK). Data is clocked in at logic low transition. I <sup>2</sup> C Serial Clock Line (SCL). Data is clocked in at logic low transition.
12	SDI/SDA	Serial Data Input/Output (SDA), when DIS = 1. Serial Data Input (SDI), when DIS = 0.
13	$\overline{\text{WP}}$	Optional Write Protect. This pin prevents any changes to the present RDAC and EEPROM contents, except when reloading the content of the EEPROM into the RDAC register. $\overline{\text{WP}}$ is activated at logic low. If this pin is not used, tie $\overline{\text{WP}}$ to $V_{\text{LOGIC}}$ .
14	SDO/ADDR1	Programmable Address (ADDR1) for Multiple Package Decoding, when DIS = 1. Serial Data Output (SDO). This is an open-drain output pin, and it needs an external pull-up resistor when DIS = 0.
15	INDEP	Linear Gain Setting Mode at Power-Up. Each string resistor is loaded from its associate memory location. If INDEP is enabled, it cannot be disabled by the software.
16	$\overline{\text{LRDAC}}$	Load RDAC. Transfers the contents of the input register to the RDAC register. This allows asynchronous RDAC update. $\overline{\text{LRDAC}}$ is activated low. If this pin is not used, tie $\overline{\text{LRDAC}}$ to $V_{\text{LOGIC}}$ .
	EPAD	Exposed Pad. Connect this exposed pad to the potential of the $V_{SS}$ pin, or, alternatively, leave it electrically unconnected. It is recommended that the pad be thermally connected to a copper plane for enhanced thermal performance.

TYPICAL PERFORMANCE CHARACTERISTICS

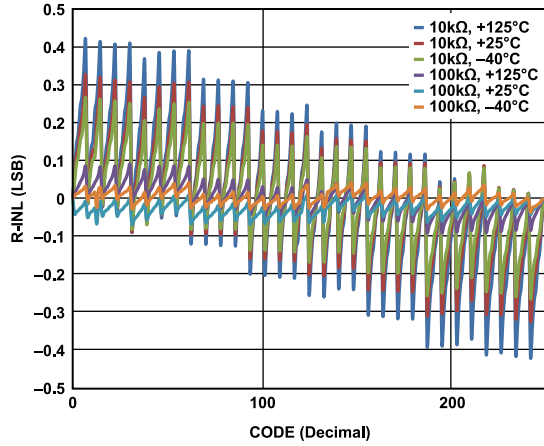


Figure 8. R-INL vs. Code (AD5141)

012

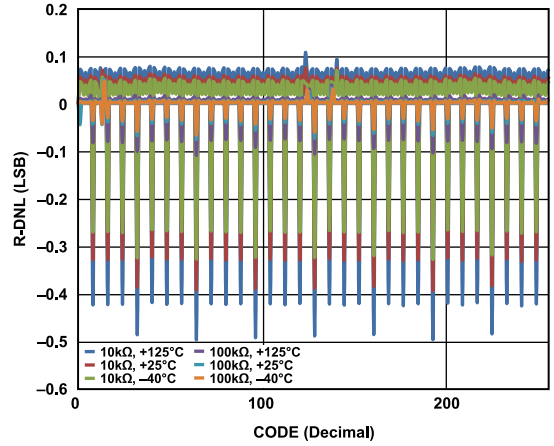


Figure 11. R-DNL vs. Code (AD5141)

015

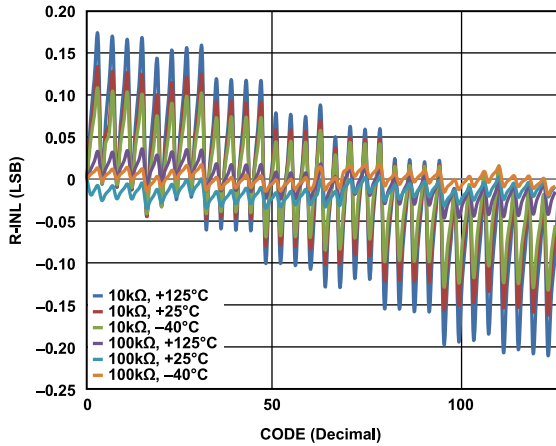


Figure 9. R-INL vs. Code (AD5121)

013

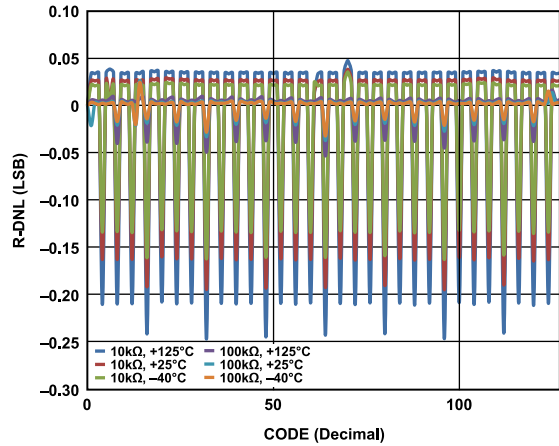


Figure 12. R-DNL vs. Code (AD5121)

016

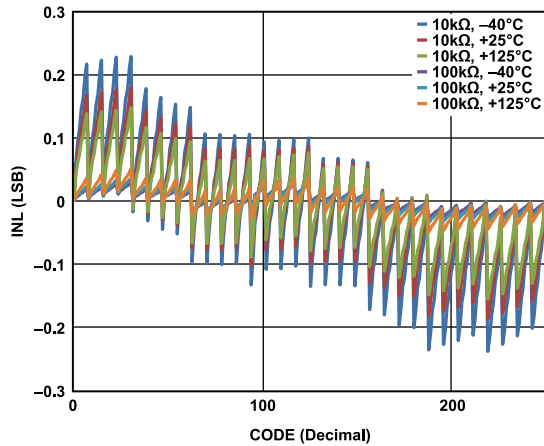


Figure 10. INL vs. Code (AD5141)

014

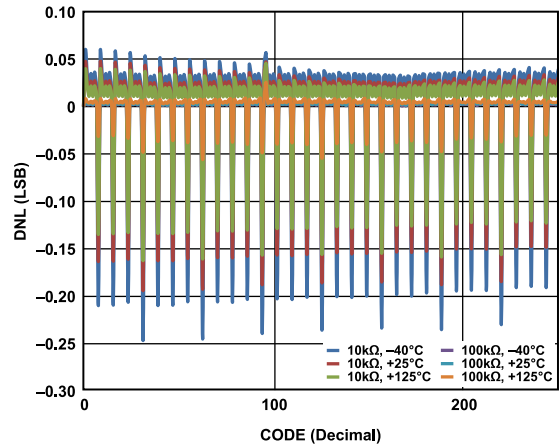


Figure 13. DNL vs. Code (AD5141)

017

TYPICAL PERFORMANCE CHARACTERISTICS

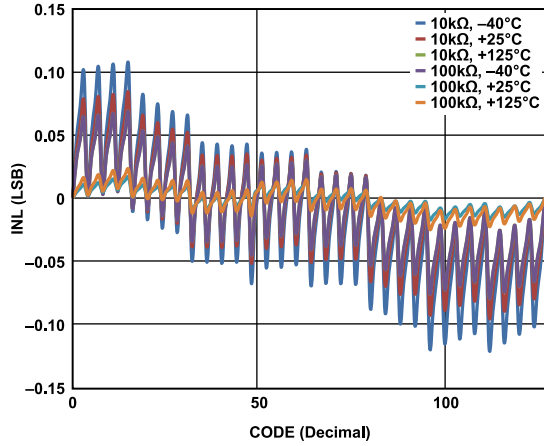


Figure 14. INL vs. Code (AD5121)

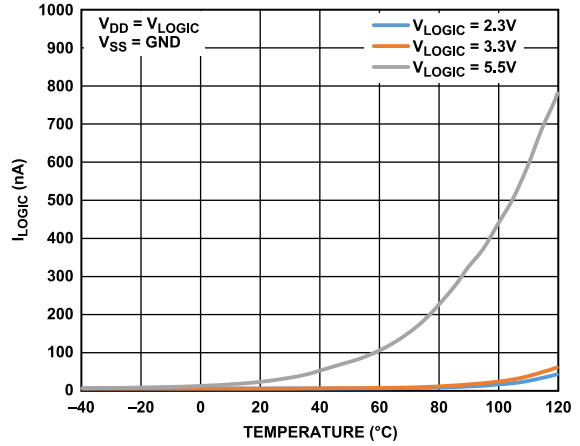


Figure 17. I<sub>LOGIC</sub> vs. Temperature

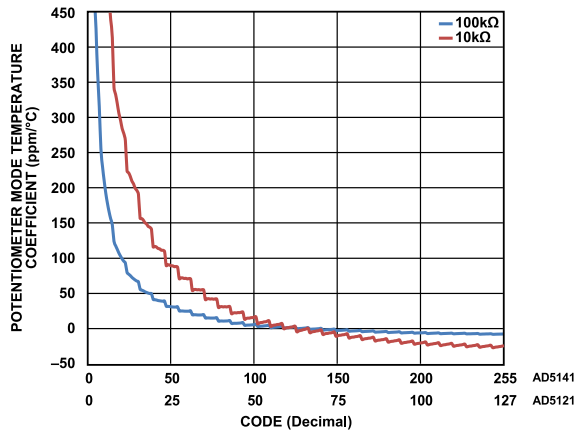


Figure 15. Potentiometer Mode Temperature Coefficient  $((\Delta V_W/V_W)/\Delta T \times 10^6)$  vs. Code

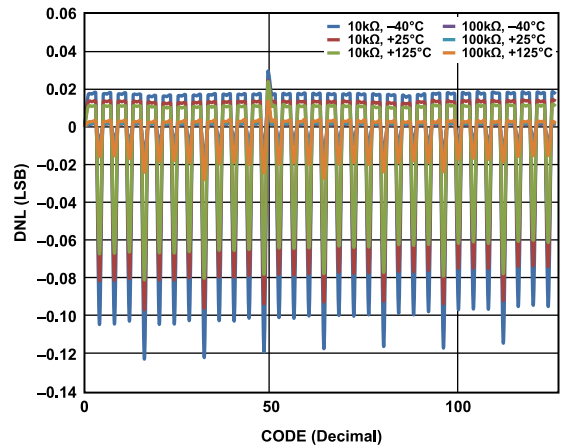


Figure 18. DNL vs. Code (AD5121)

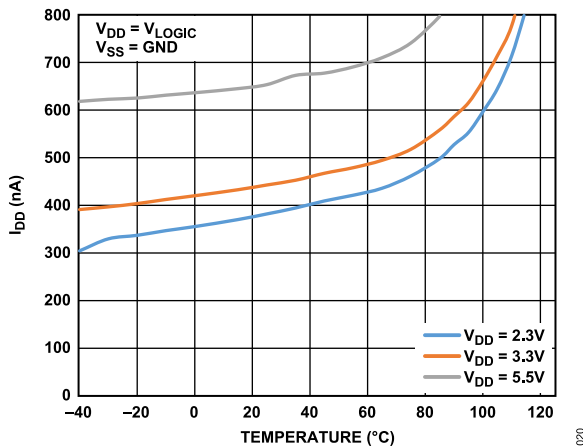


Figure 16. I<sub>DD</sub> vs. Temperature

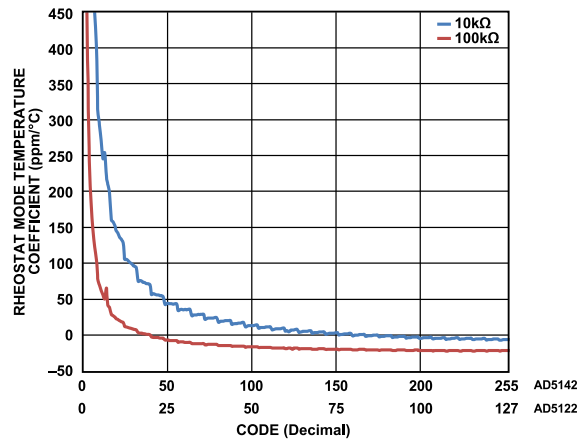


Figure 19. Rheostat Mode Temperature Coefficient  $((\Delta R_{WB}/R_{WB})/\Delta T \times 10^6)$  vs. Code

TYPICAL PERFORMANCE CHARACTERISTICS

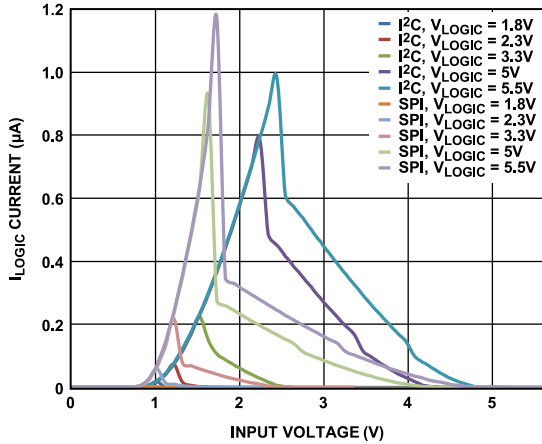


Figure 20.  $I_{LOGIC}$  Current vs. Digital Input Voltage

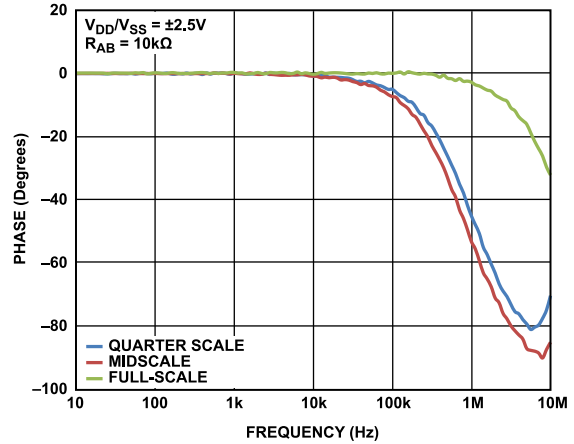


Figure 23. Normalized Phase Flatness vs. Frequency,  $R_{AB} = 10\text{ k}\Omega$

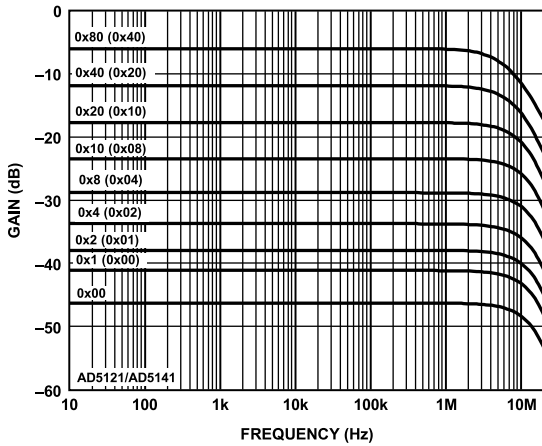


Figure 21.  $10\text{ k}\Omega$  Gain vs. Frequency vs. Code

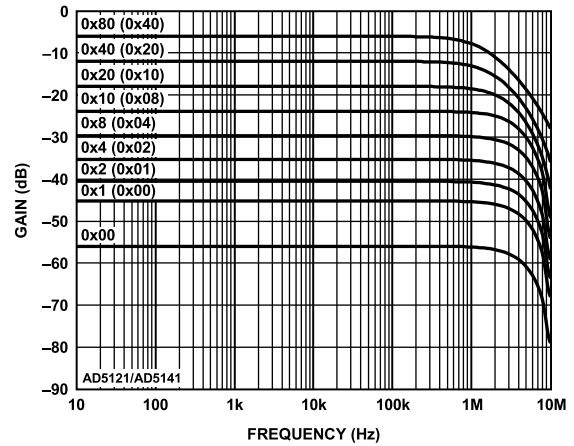


Figure 24.  $100\text{ k}\Omega$  Gain vs. Frequency vs. Code

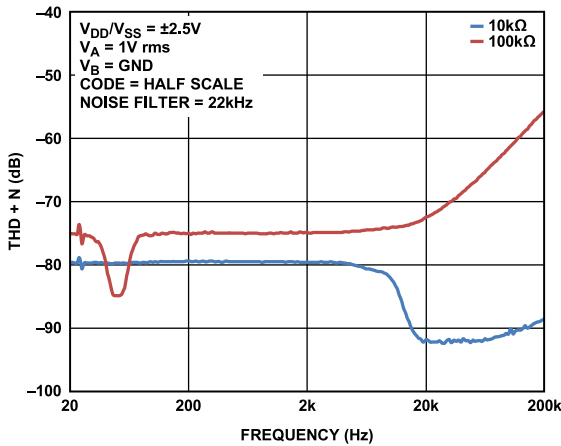


Figure 22. Total Harmonic Distortion Plus Noise (THD + N) vs. Frequency

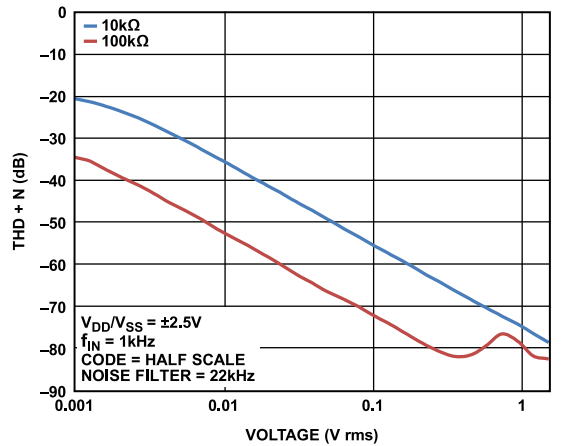


Figure 25. Total Harmonic Distortion Plus Noise (THD + N) vs. Amplitude

TYPICAL PERFORMANCE CHARACTERISTICS

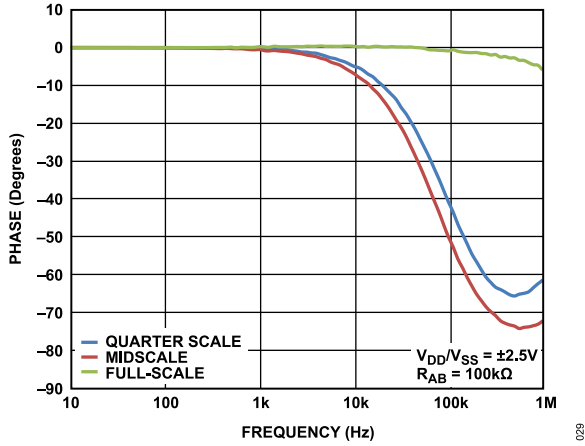


Figure 26. Normalized Phase Flatness vs. Frequency,  $R_{AB} = 100\text{ k}\Omega$

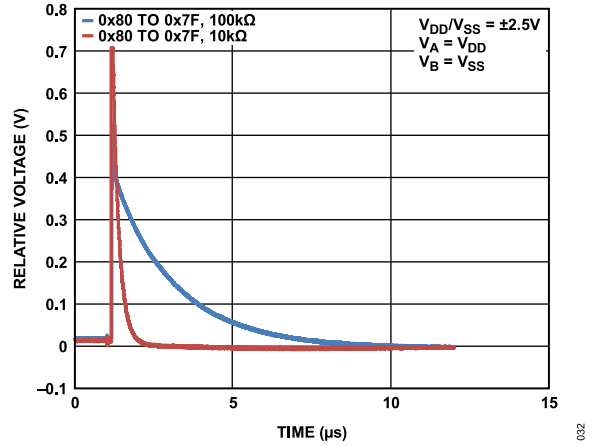


Figure 29. Maximum Transition Glitch

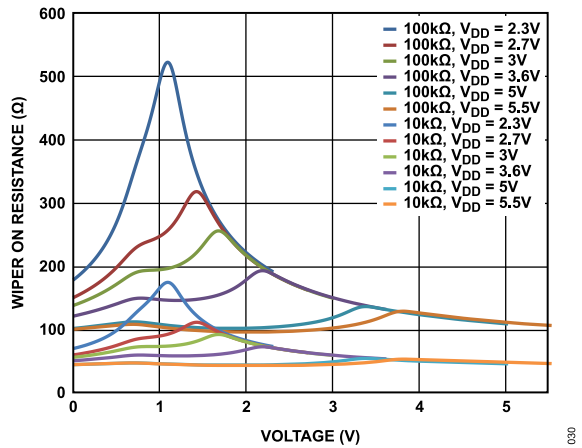


Figure 27. Incremental Wiper On Resistance vs.  $V_{DD}$

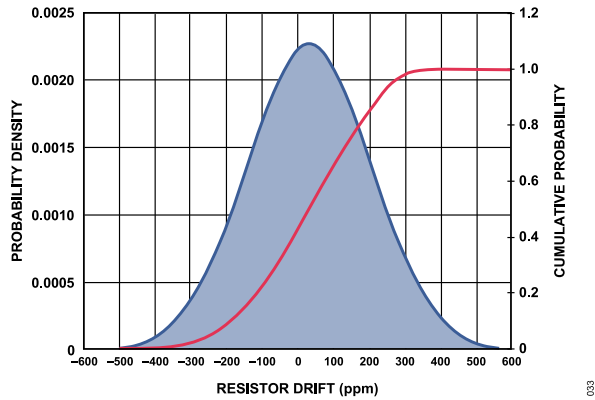


Figure 30. Resistor Lifetime Drift

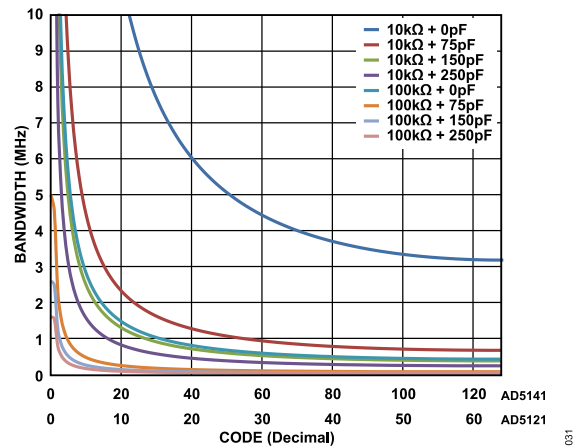


Figure 28. Maximum Bandwidth vs. Code vs. Net Capacitance

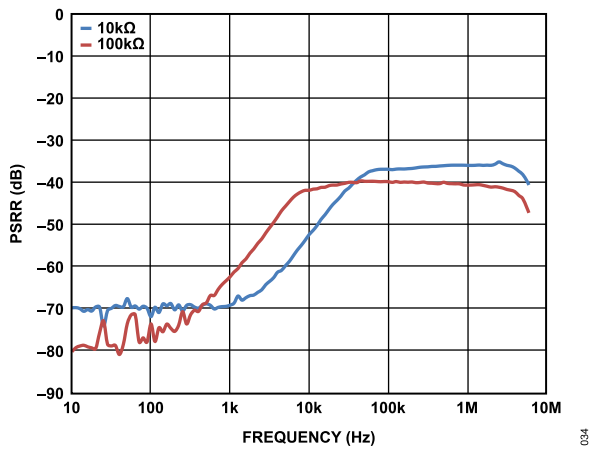


Figure 31. Power Supply Rejection Ratio (PSRR) vs. Frequency



TYPICAL PERFORMANCE CHARACTERISTICS

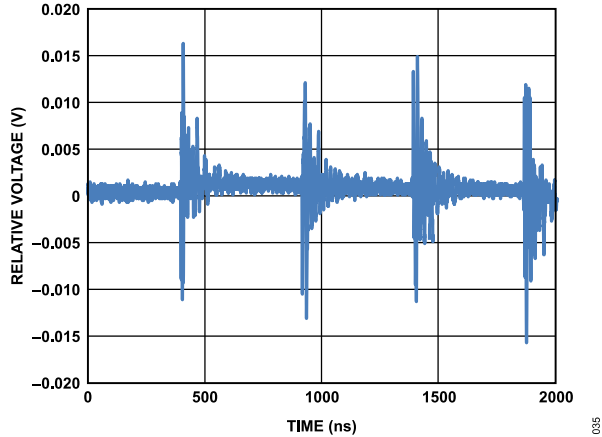


Figure 32. Digital Feedthrough

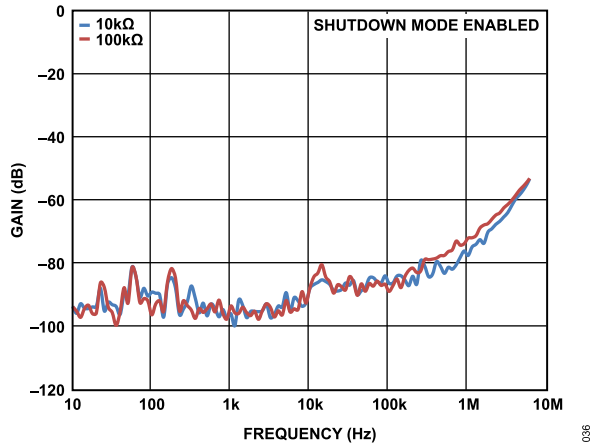


Figure 33. Shutdown Isolation vs. Frequency

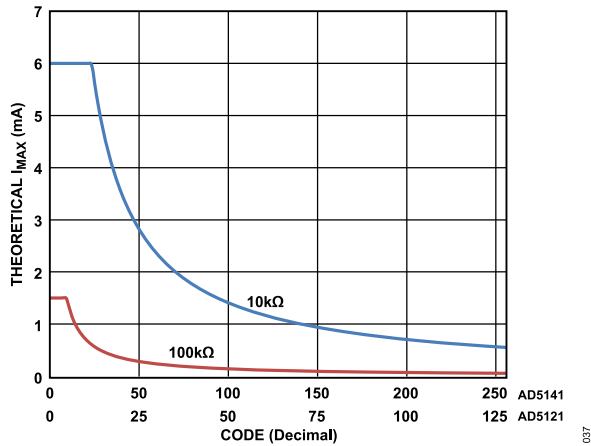


Figure 34. Theoretical Maximum Current vs. Code

TEST CIRCUITS

Figure 35 to Figure 39 define the test conditions used in the Specifications section.

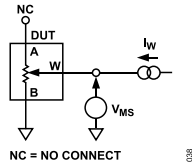


Figure 35. Resistor Integral Nonlinearity Error (Rheostat Operation; R-INL, R-DNL)

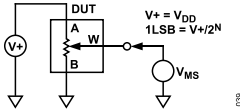


Figure 36. Potentiometer Divider Nonlinearity Error (INL, DNL)

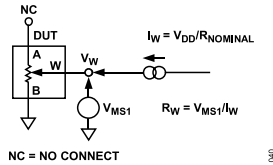


Figure 37. Wiper Resistance

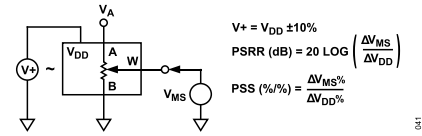


Figure 38. Power Supply Sensitivity and Power Supply Rejection Ratio (PSS and PSRR)

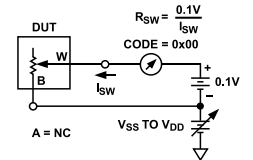


Figure 39. Incremental on Resistance

## THEORY OF OPERATION

The AD5121/AD5141 digital programmable potentiometers are designed to operate as true variable resistors for analog signals within the terminal voltage range of  $V_{SS} < V_{TERM} < V_{DD}$ . The resistor wiper position is determined by the RDAC register contents. The RDAC register acts as a scratchpad register that allows unlimited changes of resistance settings. A secondary register (the input register) can be used to preload the RDAC register data.

The RDAC register can be programmed with any position setting using the I<sup>2</sup>C or SPI interface (depending on the model). When a desirable wiper position is found, this value can be stored in the EEPROM memory. Thereafter, the wiper position is always restored to that position for subsequent power-ups. The storing of EEPROM data takes approximately 18 ms; during this time, the device is locked and does not acknowledge any new command, preventing any changes from taking place.

### RDAC REGISTER AND EEPROM

The RDAC register directly controls the position of the digital potentiometer wiper. For example, when the RDAC register is loaded with 0x80 (AD5141, 256 taps), the wiper is connected to half scale of the variable resistor. The RDAC register is a standard logic register; there is no restriction on the number of changes allowed.

It is possible to both write to and read from the RDAC register using the digital interface (see Table 13).

The contents of the RDAC register can be stored to the EEPROM using Command 9 (see Table 13). Thereafter, the RDAC register always sets at that position for any future on-off-on power supply sequence. It is possible to read back data saved into the EEPROM with Command 3 (see Table 13).

Alternatively, the EEPROM can be written to independently using Command 1 (see Table 13).

### INPUT SHIFT REGISTER

For the AD5121/AD5141, the input shift register is 16 bits wide, as shown in Figure 2. The 16-bit word consists of four control bits, followed by four address bits and by eight data bits.

If the AD5121 RDAC or EEPROM registers are read from or written to the lowest data bit (Bit 0) is ignored.

Data is loaded MSB first (Bit 15). The four control bits determine the function of the software command, as listed in Table 11 and Table 13.

Table 11. Simple Command Operation Truth Table

Command Number	Control Bits [DB15:DB12]				Address Bits [DB11:DB8] <sup>1</sup>				Data Bits [DB7:DB0] <sup>1</sup>								Operation									
	C3	C2	C1	C0	A3	A2	A1	A0	D7	D6	D5	D4	D3	D2	D1	D0										
0	0	0	0	0	X	X	X	X	X	X	X	X	X	X	X	X	NOP: do nothing									
1	0	0	0	1	0	0	0	0	D7	D6	D5	D4	D3	D2	D1	D0	Write contents of serial register data to RDAC									
2	0	0	1	0	0	0	0	0	D7	D6	D5	D4	D3	D2	D1	D0	Write contents of serial register data to input register									
3	0	0	1	1	X	0	0	0	X	X	X	X	X	X	D1	D0	Read back contents									
																	<table border="1"> <thead> <tr> <th>D1</th> <th>D0</th> <th>Data</th> </tr> </thead> <tbody> <tr> <td>0</td> <td>1</td> <td>EEPROM</td> </tr> <tr> <td>1</td> <td>1</td> <td>RDAC</td> </tr> </tbody> </table>	D1	D0	Data	0	1	EEPROM	1	1	RDAC
D1	D0	Data																								
0	1	EEPROM																								
1	1	RDAC																								
9	0	1	1	1	X	X	0	0	X	X	X	X	X	X	X	1	Copy RDAC register to EEPROM									
10	0	1	1	1	X	X	0	0	X	X	X	X	X	X	X	0	Copy EEPROM into RDAC									
14	1	0	1	1	X	X	X	X	X	X	X	X	X	X	X	X	Software reset									
15	1	1	0	0	0	0	0	0	X	X	X	X	X	X	X	D0	Software shutdown									
																	<table border="1"> <thead> <tr> <th>D0</th> <th>Condition</th> </tr> </thead> <tbody> <tr> <td>0</td> <td>Normal mode</td> </tr> <tr> <td>1</td> <td>Shutdown mode</td> </tr> </tbody> </table>	D0	Condition	0	Normal mode	1	Shutdown mode			
D0	Condition																									
0	Normal mode																									
1	Shutdown mode																									

<sup>1</sup> X = don't care.

**THEORY OF OPERATION**

**SERIAL DATA DIGITAL INTERFACE SELECTION, DIS**

The AD5121/AD5141 LFSCP provides the flexibility of a selectable interface. When the digital interface select (DIS) pin is tied low, the SPI mode is engaged. When the DIS pin is tied high, the I<sup>2</sup>C mode is engaged.

**SPI SERIAL DATA INTERFACE**

The AD5121/AD5141 contain a 4-wire, SPI-compatible digital interface (SDI, SYNC, SDO, and SCLK). The write sequence begins by bringing the SYNC line low. The SYNC pin must be held low until the complete data-word is loaded from the SDI pin. Data is loaded in at the SCLK falling edge transition, as shown in Figure 4. When SYNC returns high, the serial data-word is decoded according to the instructions in Table 13.

The AD5121/AD5141 do not require a continuous SCLK when SYNC is high. To minimize power consumption in the digital input buffers when the device is enabled, operate all serial interface pins close to the V<sub>LOGIC</sub> supply rails.

**SYNC Interruption**

In a standalone write sequence for the AD5121/AD5141, the SYNC line is kept low for 16 falling edges of SCLK, and the instruction is decoded when SYNC is pulled high. However, if the SYNC line is kept low for less than 16 falling edges of SCLK, the input shift register content is ignored, and the write sequence is considered invalid.

**SDO Pin**

The serial data output pin (SDO) serves two purposes: to read back the contents of the control, EEPROM, RDAC, and input registers using Command 3 (see Table 11 and Table 13), and to connect the AD5121/AD5141 to daisy-chain mode.

The SDO pin contains an internal open-drain output that needs an external pull-up resistor. The SDO pin is enabled when SYNC is pulled low, and the data is clocked out of SDO on the rising edge of SCLK.

**Daisy-Chain Connection**

Daisy-chaining minimizes the number of port pins required from the controlling IC. As shown in Figure 40, the SDO pin of one package must be tied to the SDI pin of the next package. The clock period may need to be increased because of the propagation delay of the line between subsequent devices. When two AD5121/AD5141 devices are daisy chained, 32 bits of data are required. The first 16 bits assigned to U2, and the second 16 bits assigned to U1, as shown in Figure 41. Keep the SYNC pin low until all 32 bits are clocked into their respective serial registers. The SYNC pin is then pulled high to complete the operation. A typical connection is shown in Figure 40.

To prevent data from mislocking (for example, due to noise) the device includes an internal counter, if the clock falling edges count is not a multiple of 8, the device ignores the command. A valid clock count is 16, 24, or 32. The counter resets when SYNC returns high.

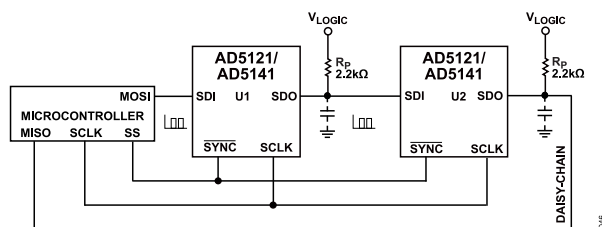


Figure 40. Daisy-Chain Configuration

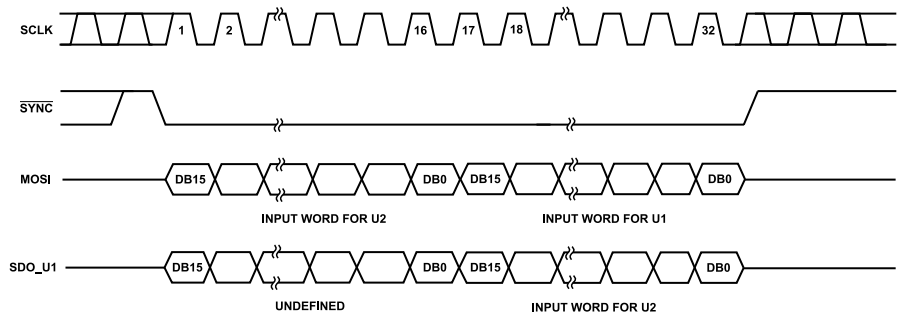


Figure 41. Daisy-Chain Diagram

## THEORY OF OPERATION

I<sup>2</sup>C SERIAL DATA INTERFACE

The AD5141 has 2-wire, I<sup>2</sup>C-compatible serial interface. These devices can be connected to an I<sup>2</sup>C bus as a slave device, under the control of a master device. See Figure 3 for a timing diagram of a typical write sequence.

The AD5141 supports standard (100 kHz) and fast (400 kHz) data transfer modes. Support is not provided for 10-bit addressing and general call addressing.

The 2-wire serial bus protocol operates as follows:

1. The master initiates a data transfer by establishing a start condition, which is when a high-to-low transition on the SDA line occurs while SCL is high. The following byte is the address byte, which consists of the 7-bit slave address and an R/W bit. The slave device corresponding to the transmitted address responds by pulling SDA low during the ninth clock pulse (this is called the acknowledge bit). At this stage, all other devices on the bus remain idle while the selected device waits for data to be written to, or read from, its shift register. If the R/W bit is set high, the master reads from the slave device. However, if the R/W bit is set low, the master writes to the slave device.
2. Data is transmitted over the serial bus in sequences of nine clock pulses (eight data bits followed by an acknowledge bit). The transitions on the SDA line must occur during the low period of SCL and remain stable during the high period of SCL.
3. When all data bits have been read from or written to, a stop condition is established. In write mode, the master pulls the SDA line high during the tenth clock pulse to establish a stop condition. In read mode, the master issues a no acknowledge for the ninth clock pulse (that is, the SDA line remains high). The master then brings the SDA line low before the tenth clock pulse, and then high again during the tenth clock pulse to establish a stop condition.

I<sup>2</sup>C Address

The AD5121/AD5141 has two different pin address options available, as shown in Table 12.

Table 12. 16-Lead LFCSP Device Address Selection

ADDR0 Pin	ADDR1 Pin	7-Bit I <sup>2</sup> C Device Address
V <sub>LOGIC</sub>	V <sub>LOGIC</sub>	0100000
No connect <sup>1</sup>	V <sub>LOGIC</sub>	0100010
GND	V <sub>LOGIC</sub>	0100011
V <sub>LOGIC</sub>	No connect <sup>1</sup>	0101000
No connect <sup>1</sup>	No connect <sup>1</sup>	0101010
GND	No connect <sup>1</sup>	0101011
V <sub>LOGIC</sub>	GND	0101100
No connect <sup>1</sup>	GND	0101110
GND	GND	0101111

<sup>1</sup> Not available in bipolar mode ( $V_{SS} < 0$  V) or in low voltage mode ( $V_{LOGIC} = 1.8$  V).

## Write Operation

When writing to the AD5121/AD5141, the user must begin with a start command followed by an address byte ( $R/\bar{W} = 0$ ), after which the device acknowledges that it is prepared to receive data by pulling SDA low.

Two bytes of data are then written to the DAC, the most significant byte followed by the least significant byte. Both of these data bytes are acknowledged by the AD5121/AD5141. A stop condition follows. The write operations for the AD5121/AD5141 are shown in Figure 42 and Figure 43.

A repeated write function gives the user flexibility to update the device a number of times after addressing the device only once, as shown in Figure 43.

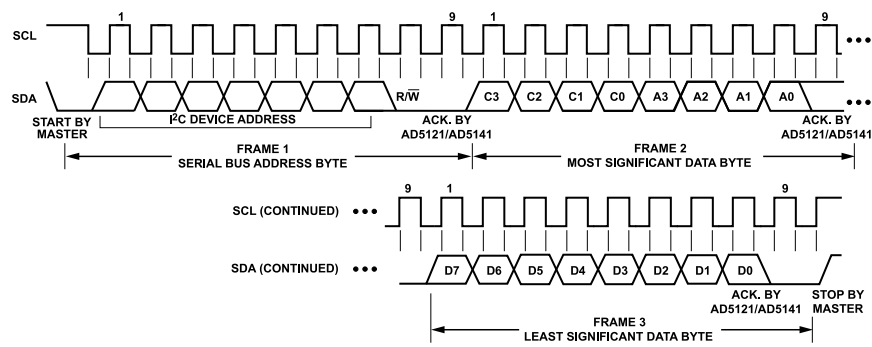


Figure 42. AD5121/AD5141 Interface Write Command

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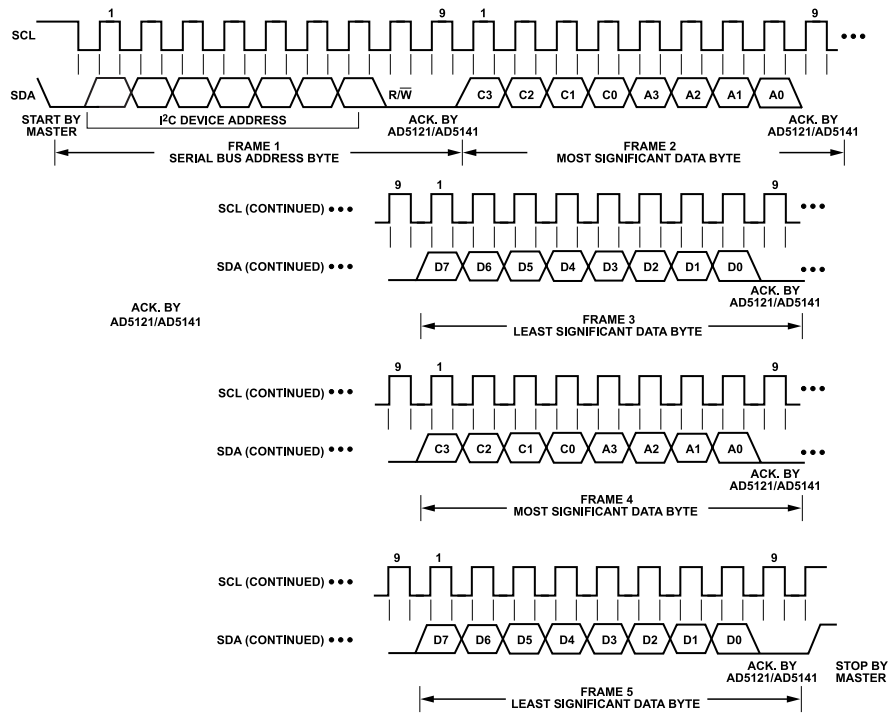


Figure 43. AD5121/AD5141 Interface Multiple Write

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**EEPROM Write Acknowledge Polling**

After each write operation to the EEPROM, an internal write cycle begins. The I<sup>2</sup>C interface of the device is disabled. To determine if the internal write cycle is complete and the I<sup>2</sup>C interface is enabled, interface polling can be executed. I<sup>2</sup>C interface polling can be conducted by sending a start condition, followed by the slave address and the write bit. If the I<sup>2</sup>C interface responds with an acknowledge, the write cycle is complete, and the interface is ready to proceed with further operations. Otherwise, I<sup>2</sup>C interface polling can be repeated until it succeeds.

**Read Operation**

The AD5121/AD5141 allow readback of the contents of the RDAC register and EEPROM memory through the I<sup>2</sup>C interface by using Command 3 (see Table 13).

When reading data back from the AD5121/AD5141, the user must first issue a readback command to the device. The readback com-

mand begins with a start command, followed by an address byte (R/W = 0), after which the device acknowledges that it is prepared to receive data by pulling SDA low.

Two bytes of data are then written to the AD5121/AD5141, the most significant byte followed by the least significant byte. Both of these data bytes are acknowledged by the AD5121/AD5141. A stop condition follows. These bytes contain the read instruction, which enables readback of the RDAC register and EEPROM memory. The user can then read back the data. This begins with a start command followed by an address byte (R/W = 1), after which the device acknowledges that it is prepared to transmit data by pulling SDA low. Two bytes of data are then read from the device, which are both acknowledged by the master, as shown in Figure 44. A stop condition follows. If the master does not acknowledge the first byte, the second byte is not transmitted by the AD5121/AD5141.

The AD5121/AD5141 do not support repeat readback.

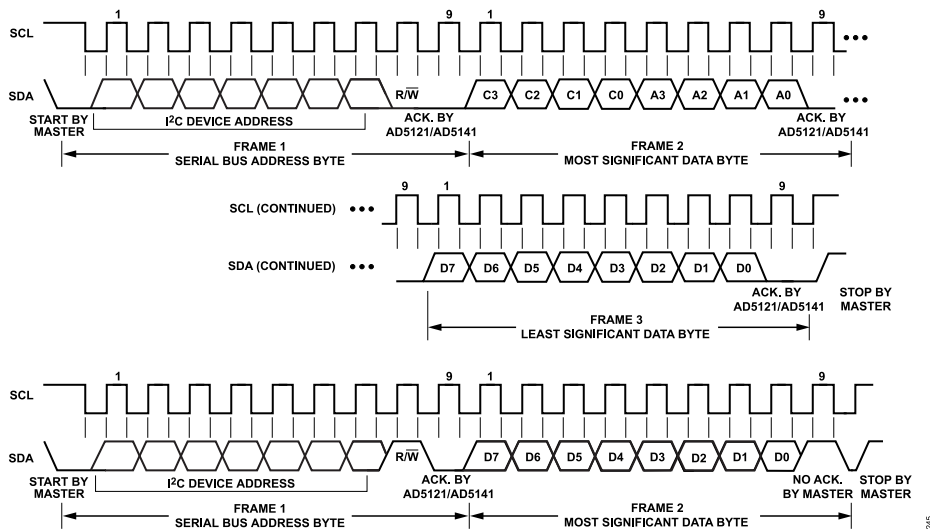


Figure 44. AD5121/AD5141 Interface Read Command

## THEORY OF OPERATION

## ADVANCED CONTROL MODES

The AD5121/AD5141 digital potentiometers include a set of user programming features to address the wide number of applications for these universal adjustment devices (see [Table 13](#) and [Table 15](#)).

Key programming features include the following:

► Input register

- Linear gain setting mode
- Low wiper resistance feature
- Linear increment and decrement instructions
- $\pm 6$  dB increment and decrement instructions
- Burst mode (I<sup>2</sup>C only)
- Reset
- Shutdown mode

Table 13. Advance Commands Operation Truth Table

Command Number	Control Bits [DB15:DB12]				Address Bits [DB11:DB8] <sup>1</sup>				Data Bits [DB7:DB0] <sup>1</sup>								Operation		
	C3	C2	C1	C0	A3	A2	A1	A0	D7	D6	D5	D4	D3	D2	D1	D0			
0	0	0	0	0	X	X	X	X	X	X	X	X	X	X	X	X	NOP: do nothing		
1	0	0	0	1	0	A2	0	A0	D7	D6	D5	D4	D3	D2	D1	D0	Write contents of serial register data to RDAC		
2	0	0	1	0	0	A2	0	A0	D7	D6	D5	D4	D3	D2	D1	D0	Write contents of serial register data to input register		
3	0	0	1	1	X	A2	A1	A0	X	X	X	X	X	X	D1	D0	Read back contents		
																	D1	D0	Data
																	0	0	Input register
																	0	1	EEPROM
																	Control register		
																	RDAC		
4	0	1	0	0	A3	A2	0	A0	X	X	X	X	X	X	X	1	Linear RDAC increment		
5	0	1	0	0	A3	A2	0	A0	X	X	X	X	X	X	X	0	Linear RDAC decrement		
6	0	1	0	1	A3	A2	0	A0	X	X	X	X	X	X	X	1	+6 dB RDAC increment		
7	0	1	0	1	A3	A2	0	A0	X	X	X	X	X	X	X	0	-6 dB RDAC decrement		
8	0	1	1	0	A3	A2	0	A0	X	X	X	X	X	X	X	X	Copy input register to RDAC (software LRDAC)		
9	0	1	1	1	0	A2	0	A0	X	X	X	X	X	X	X	1	Copy RDAC register to EEPROM		
10	0	1	1	1	0	A2	0	A0	X	X	X	X	X	X	X	0	Copy EEPROM into RDAC		
11	1	0	0	0	0	A2	0	A0	D7	D6	D5	D4	D3	D2	D1	D0	Write contents of serial register data to EEPROM		
12	1	0	0	1	A3	A2	0	A0	1	X	X	X	X	X	X	X	Top scale		
																	D0 = 0; normal mode		
																	D0 = 1; shutdown mode		
13	1	0	0	1	A3	A2	0	A0	0	X	X	X	X	X	X	X	Bottom scale		
																	D0 = 1; enter		
																	D0 = 0; exit		
14	1	0	1	1	X	X	X	X	X	X	X	X	X	X	X	X	Software reset		
15	1	1	0	0	A3	A2	0	A0	X	X	X	X	X	X	X	X	Software shutdown		
																	D0 = 0; normal mode		
																	D0 = 1; device placed in shutdown mode		
16	1	1	0	1	X	X	X	X	X	X	X	D3	D2	D1	D0	Copy serial register data to control register, refer to <a href="#">Table 15</a>			

<sup>1</sup> X= don't care.



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Table 14. Address Bits

A3	A2	A1	A0	Potentiometer Mode		Linear Gain Setting Mode		Stored RDAC Memory
				Input Register	RDAC Register	Input Register	RDAC Register	
1	X <sup>1</sup>	X <sup>1</sup>	X <sup>1</sup>	All channels	All channels	All channels	All channels	Not applicable
0	0	0	0	RDAC	RDAC	R <sub>WB</sub>	R <sub>WB</sub>	RDAC/R <sub>WB</sub>
0	1	0	0	Not applicable	Not applicable	R <sub>AW</sub>	R <sub>AW</sub>	Not applicable
0	0	0	1	Not applicable	Not applicable	Not applicable	Not applicable	R <sub>AW</sub>
0	0	1	0	Not applicable	Not applicable	Not applicable	Not applicable	MSB tolerance
0	0	1	1	Not applicable	Not applicable	Not applicable	Not applicable	LSB tolerance

<sup>1</sup> X= don't care.

Table 15. Control Register Bit Descriptions

Bit Name	Description
D0	RDAC register write protect 0 = wiper position frozen to value in EEPROM memory 1 = allows update of wiper position through digital interface (default)
D1	EEPROM program enable 0 = EEPROM program disabled 1 = enables device for EEPROM program (default)
D2	Linear setting mode/potentiometer mode 0 = potentiometer mode (default) 1 = linear gain setting mode
D3	Burst mode (I <sup>2</sup> C only) 0 = disabled (default) 1 = enabled (no disable after stop or repeat start condition)

## Input Register

The AD5121/AD5141 include one input register per RDAC register. This register allows preloading of the value for the associated RDAC register.

This feature allows a synchronous and asynchronous update of one or all the RDAC registers at the same time.

These registers can be written to using Command 2 and read back from using Command 3 (see Table 13).

The transfer from the input register to the RDAC register is done asynchronously by the LRDAC pin or synchronously by Command 8 (see Table 13).

If new data is loaded in an RDAC register, this RDAC register automatically overwrites the associated input register.

## Linear Gain Setting Mode

The proprietary architecture of the AD5121/AD5141 allows the independent control of each string resistor, R<sub>AW</sub> and R<sub>WB</sub>. To enable this feature, use Command 16 (see Table 13) to set Bit D2 of the control register (see Table 15).

This mode of operation can control the potentiometer as two independent rheostats connected at a single point, W terminal, as

opposed to potentiometer mode where each resistor is complementary,  $R_{AW} = R_{AB} - R_{WB}$ .

This feature enables a second input and an RDAC register per channel, as shown in Table 13; however, the actual RDAC contents remain unchanged. The same operations are valid for potentiometer and linear gain setting modes.

If the INDEP pin is pulled high, the device powers up in linear gain setting mode and loads the values stored in the associated memory locations for each channel (see Table 14). The INDEP pin and D2 bit are connected internally to a logic OR gate, if any or both are 1, the devices cannot operate in potentiometer mode.

## Low Wiper Resistance Feature

The AD5121/AD5141 include two commands to reduce the wiper resistance between the terminals when they achieve full scale or zero scale. These extra positions are called bottom scale, BS, and top scale, TS. The resistance between Terminal A and Terminal W at top scale is specified as R<sub>TS</sub>. Similarly, the bottom scale resistance between Terminal B and Terminal W is specified as R<sub>BS</sub>.

The contents of the RDAC registers are unchanged by entering in these positions. There are two ways to exit from top scale and bottom scale: by using Command 12 or Command 13 (see Table

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13); or by loading new data in an RDAC register, which includes increment/decrement operations and a shutdown command.

Table 16 and Table 17 show the truth tables for the top scale position and the bottom scale position, respectively, when linear gain setting mode is enabled.

**Table 16. Top Scale Truth Table**

Linear Gain Setting Mode		Potentiometer Mode	
R <sub>AW</sub>	R <sub>WB</sub>	R <sub>AW</sub>	R <sub>WB</sub>
R <sub>AB</sub>	R <sub>AB</sub>	R <sub>TS</sub>	R <sub>AB</sub>

**Table 17. Bottom Scale Truth Table**

Linear Gain Setting Mode		Potentiometer Mode	
R <sub>AW</sub>	R <sub>WB</sub>	R <sub>AW</sub>	R <sub>WB</sub>
R <sub>TS</sub>	R <sub>BS</sub>	R <sub>AB</sub>	R <sub>BS</sub>

### Linear Increment and Decrement Instructions

The increment and decrement commands (Command 4 and Command 5 in Table 13) are useful for linear step adjustment applications. These commands simplify microcontroller software coding by allowing the controller to send an increment or decrement command to the device. The adjustment can be individual or in a ganged potentiometer arrangement, where all wiper positions are changed at the same time.

For an increment command, executing Command 4 automatically moves the wiper to the next resistance segment position. This command can be executed in a single channel or multiple channels.

### ±6 dB Increment and Decrement Instructions

Two programming instructions produce logarithmic taper increment or decrement of the wiper position control by an individual potentiometer or by a ganged potentiometer arrangement where all RDAC register positions are changed simultaneously. The +6 dB increment is activated by Command 6, and the -6 dB decrement is activated by Command 7 (see Table 13). For example, starting with the zero-scale position and executing Command 6 ten times moves the wiper in 6 dB steps to the full-scale position. When the wiper position is near the maximum setting, the last 6 dB increment instruction causes the wiper to go to the full-scale position (see Table 18).

Incrementing the wiper position by +6 dB essentially doubles the RDAC register value, whereas decrementing the wiper position by -6 dB halves the register content. Internally, the AD5121/AD5141 use shift registers to shift the bits left and right to achieve a ±6 dB increment or decrement. These functions are useful for various audio/video level adjustments, especially for white LED brightness settings in which human visual responses are more sensitive to large adjustments than to small adjustments.

**Table 18. Detailed Left Shift and Right Shift Functions for the ±6 dB Step Increment and Decrement**

Left Shift (+6 dB/Step)	Right Shift (-6 dB/Step)
0000 0000	1111 1111
0000 0001	0111 1111
0000 0010	0011 1111
0000 0100	0001 1111
0000 1000	0000 1111
0001 0000	0000 0111
0010 0000	0000 0011
0100 0000	0000 0001
1000 0000	0000 0000
1111 1111	0000 0000

### Burst Mode (I<sup>2</sup>C Only)

By enabling the burst mode, multiple data bytes can be sent to the device consecutively. After the command byte, the device interprets the consecutive bytes as data bytes for the first command.

A new command can be sent by generating a repeat start or by a stop and start condition.

The burst mode is activated by setting Bit D3 of the control register (see Table 15), and if a reset or power-down is performed, it automatically resets.

### Reset

The AD5121/AD5141 can be reset through software by executing Command 14 (see Table 13) or through hardware on the low pulse of the RESET pin. The reset command loads the RDAC register with the contents of the EEPROM and takes approximately 30 μs. The EEPROM is preloaded to midscale at the factory, and initial power-up is, accordingly, at midscale. Tie RESET to V<sub>DD</sub> if the RESET pin is not used.

### Shutdown Mode

The AD5121/AD5141 can be placed in shutdown mode by executing the software shutdown command, Command 15 (see Table 13); and by setting the LSB (D0) to 1. This feature places the RDAC in a special state. The contents of the RDAC register are unchanged by entering shutdown mode. However, all commands listed in Table 13 are supported while in shutdown mode. Execute Command 15 (see Table 13) and set the LSB (D0) to 0 to exit shutdown mode.

**Table 19. Truth Table for Shutdown Mode**

A2	Linear Gain Setting Mode		Potentiometer Mode	
	AW	WB	AW	WB
0	N/A <sup>1</sup>	Open	Open	R <sub>BS</sub>
1	Open	N/A <sup>1</sup>	N/A <sup>1</sup>	N/A <sup>1</sup>

<sup>1</sup> N/A = not applicable.

## THEORY OF OPERATION

### EEPROM OR RDAC REGISTER PROTECTION

The EEPROM and RDAC registers can be protected by disabling any update to these registers. This can be done by using software or by using hardware. If these registers are protected by software, set Bit D0 and/or Bit D1 (see Table 15), which protects the RDAC and EEPROM registers independently.

If the registers are protected by hardware, pull the  $\overline{WP}$  pin low. If the  $\overline{WP}$  pin is pulled low when the device is executing a command, the protection is not enabled until the command is completed.

When RDAC is protected, the only operation allowed is to copy the EEPROM into the RDAC register.

### LOAD RDAC INPUT REGISTER ( $\overline{LRDAC}$ )

$\overline{LRDAC}$  software or hardware transfers data from the input register to the RDAC register (and therefore updates the wiper position). By default, the input register has the same value as the RDAC register; therefore, only the input register that has been updated using Command 2 is updated.

Software  $\overline{LRDAC}$ , Command 8, allows updating of a single RDAC register or all of the channels at once (see Table 13). This is a synchronous update.

The hardware  $\overline{LRDAC}$  is completely asynchronous and copies the content of all the input registers into the associated RDAC registers. If a command is executed, to avoid data corruption, any transition in the  $\overline{LRDAC}$  pin is ignored by the device.

### INDEP PIN

If the INDEP pin is pulled high at power-up, the device operates in linear gain setting mode, loading each string resistor,  $R_{AW}$  and  $R_{WB}$ , with the value stored into the EEPROM (see Table 14). If the pin is pulled low, the device powers up in potentiometer mode.

The INDEP pin and the D2 bit are connected internally to a logic OR gate, if any or both are 1, the device cannot operate in potentiometer mode (see Table 15).

### RDAC ARCHITECTURE

To achieve optimum performance, Analog Devices, Inc., uses a proprietary RDAC segmentation architecture for all the digital potentiometers. In particular, the AD5121/AD5141 employ a three-stage segmentation approach, as shown in Figure 45. The AD5121/AD5141 wiper switch is designed with the transmission gate CMOS topology and with the gate voltage derived from  $V_{DD}$  and  $V_{SS}$ .

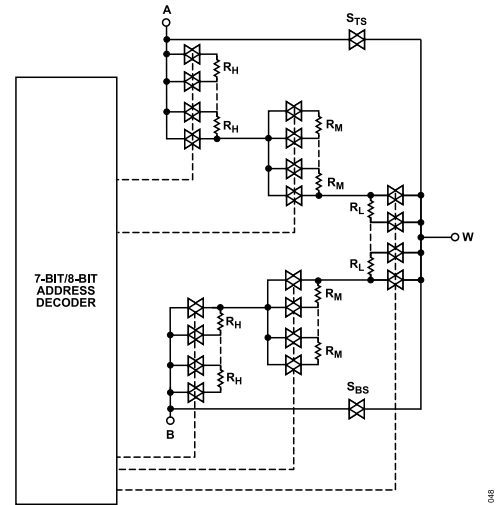


Figure 45. AD5121/AD5141 Simplified RDAC Circuit

### Top Scale/Bottom Scale Architecture

In addition, the AD5121/AD5141 include new positions to reduce the resistance between terminals. These positions are called bottom scale and top scale. At bottom scale, the typical wiper resistance decreases from 130  $\Omega$  to 60  $\Omega$  ( $R_{AB} = 100$  k $\Omega$ ). At top scale, the resistance between Terminal A and Terminal W is decreased by 1 LSB, and the total resistance is reduced to 60  $\Omega$  ( $R_{AB} = 100$  k $\Omega$ ).

### PROGRAMMING THE VARIABLE RESISTOR

#### Rheostat Operation— $\pm 8\%$ Resistor Tolerance

The AD5121/AD5141 operate in rheostat mode when only two terminals are used as a variable resistor. The unused terminal can be floating, or it can be tied to Terminal W, as shown in Figure 46.

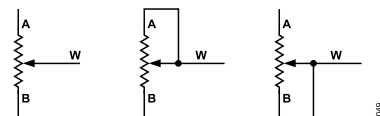


Figure 46. Rheostat Mode Configuration

The nominal resistance between Terminal A and Terminal B,  $R_{AB}$ , is 10 k $\Omega$  or 100 k $\Omega$ , and has 128/256 tap points accessed by the wiper terminal. The 7-bit/8-bit data in the RDAC latch is decoded to select one of the 128/256 possible wiper settings. The general equations for determining the digitally programmed output resistance between Terminal W and Terminal B are

AD5121:

$$R_{WB}(D) = \frac{D}{128} \times R_{AB} + R_W \quad \text{From } 0x00 \text{ to } 0x7F \quad (1)$$

AD5141:

$$R_{WB}(D) = \frac{D}{256} \times R_{AB} + R_W \quad \text{From } 0x00 \text{ to } 0xFF \quad (2)$$

where:

## THEORY OF OPERATION

$D$  is the decimal equivalent of the binary code in the 7-bit/8-bit RDAC register.

$R_{AB}$  is the end-to-end resistance.

$R_W$  is the wiper resistance.

In potentiometer mode, similar to the mechanical potentiometer, the resistance of the RDAC between Terminal W and Terminal A also produces a digitally controlled complementary resistance,  $R_{WA}$ .  $R_{WA}$  also gives a maximum of 8% absolute resistance error.  $R_{WA}$  starts at the maximum resistance value and decreases as the data loaded into the latch increases. The general equations for this operation are

AD5121:

$$R_{AW}(D) = \frac{128-D}{128} \times R_{AB} + R_W \quad \text{From } 0x00 \text{ to } 0x7F \quad (3)$$

AD5141:

$$R_{AW}(D) = \frac{256-D}{256} \times R_{AB} + R_W \quad \text{From } 0x00 \text{ to } 0xFF \quad (4)$$

where:

$D$  is the decimal equivalent of the binary code in the 7-bit/8-bit RDAC register.

$R_{AB}$  is the end-to-end resistance.

$R_W$  is the wiper resistance.

If the device is configured in linear gain setting mode, the resistance between Terminal W and Terminal A is directly proportional to the code loaded in the associate RDAC register. The general equations for this operation are

AD5121:

$$R_{AW}(D) = \frac{D}{128} \times R_{AB} + R_W \quad \text{From } 0x00 \text{ to } 0x7F \quad (5)$$

AD5141:

$$R_{AW}(D) = \frac{D}{256} \times R_{AB} + R_W \quad \text{From } 0x00 \text{ to } 0xFF \quad (6)$$

where:

$D$  is the decimal equivalent of the binary code in the 7-bit/8-bit RDAC register.

$R_{AB}$  is the end-to-end resistance.

$R_W$  is the wiper resistance.

In the bottom scale condition or top scale condition, a finite total wiper resistance of 40  $\Omega$  is present. Regardless of which setting the device is operating in, limit the current between Terminal A to Terminal B, Terminal W to Terminal A, and Terminal W to Terminal B, to the maximum continuous current of  $\pm 6$  mA or to the pulse current specified in Table 7. Otherwise, degradation or possible destruction of the internal switch contact can occur.

### Calculate the Actual End-to-End Resistance

The resistance tolerance is stored in the internal memory during factory testing. Therefore, the actual end-to-end resistance can be

calculated (which is valuable for calibration, tolerance matching, and precision applications).

The resistance tolerance (in percentage) is stored in fixed point format, using a 16-bit sign magnitude binary. The sign bit (0 = negative and 1 = positive) and the integer part are located in Address 0x02, as shown in Table 20. Address 0x03 contains the fractional part, as shown in Table 20.

That is, if the data readback from Address 0x02 is 00000010, and the data readback from Address 0x03 is 10110000, the end-to-end resistance can be calculated as follows.

For Memory Map Address 0x02, DB[7] = 0 = negative, and DB[6:0] = 0000010 = 2.

For Memory Map Address 0x03, DB[7:0] = 10110000 =  $176 \times 2^{-8} = 0.6875$ , and therefore, tolerance =  $-2.6875\%$ , and  $R_{AB} = 9.731$  k $\Omega$ .

## PROGRAMMING THE POTENTIOMETER DIVIDER

### Voltage Output Operation

The digital potentiometer easily generates a voltage divider at wiper-to-B and wiper-to-A that is proportional to the input voltage at A to B, as shown in Figure 47.

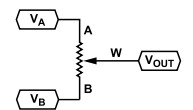


Figure 47. Potentiometer Mode Configuration

Connecting Terminal A to 5 V and Terminal B to ground produces an output voltage at the Wiper W to Terminal B ranging from 0 V to 5 V. The general equation defining the output voltage at  $V_W$  with respect to ground for any valid input voltage applied to Terminal A and Terminal B is

$$V_W(D) = \frac{R_{WB}(D)}{R_{AB}} \times V_A + \frac{R_{AW}(D)}{R_{AB}} \times V_B \quad (7)$$

where:

$R_{WB}(D)$  can be obtained from Equation 1 and Equation 2.

$R_{AW}(D)$  can be obtained from Equation 3 and Equation 4.

Operation of the digital potentiometer in the divider mode results in a more accurate operation over temperature. Unlike the rheostat mode, the output voltage is dependent mainly on the ratio of the internal resistors,  $R_{AW}$  and  $R_{WB}$ , and not the absolute values. Therefore, the temperature drift reduces to 5 ppm/ $^{\circ}\text{C}$ .

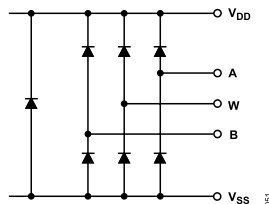
## THEORY OF OPERATION

Table 20. End-to-End Resistance Tolerance Bytes

Memory Map Address	Data Byte							
	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
0x02	Sign	$2^6$	$2^5$	$2^4$	$2^3$	$2^2$	$2^1$	$2^0$
0x03	$2^{-1}$	$2^{-2}$	$2^{-3}$	$2^{-4}$	$2^{-5}$	$2^{-6}$	$2^{-7}$	$2^{-8}$

## TERMINAL VOLTAGE OPERATING RANGE

The AD5121/AD5141 are designed with internal ESD diodes for protection. These diodes also set the voltage boundary of the terminal operating voltages. Positive signals present on Terminal A, Terminal B, or Terminal W that exceed  $V_{DD}$  are clamped by the forward-biased diode. There is no polarity constraint between  $V_A$ ,  $V_W$ , and  $V_B$ , but they cannot be higher than  $V_{DD}$  or lower than  $V_{SS}$ .

Figure 48. Maximum Terminal Voltages Set by  $V_{DD}$  and  $V_{SS}$ 

## POWER-UP SEQUENCE

Because there are diodes to limit the voltage compliance at Terminal A, Terminal B, and Terminal W (see Figure 48), it is important to power up  $V_{DD}$  first before applying any voltage to Terminal A, Terminal B, and Terminal W. Otherwise, the diode is forward-biased such that  $V_{DD}$  is powered unintentionally. The ideal power-up sequence is  $V_{SS}$ ,  $V_{DD}$ ,  $V_{LOGIC}$ , digital inputs, and  $V_A$ ,  $V_B$ , and  $V_W$ . The order of powering  $V_A$ ,  $V_B$ ,  $V_W$ , and digital inputs is not important as long as they are powered after  $V_{SS}$ ,  $V_{DD}$ , and  $V_{LOGIC}$ . Regardless of the power-up sequence and the ramp rates of the power supplies, once  $V_{LOGIC}$  is powered, the power-on preset activates, which restores EEPROM values to the RDAC registers.

## LAYOUT AND POWER SUPPLY BIASING

It is always a good practice to use a compact, minimum lead length layout design. Ensure that the leads to the input are as direct as possible with a minimum conductor length. Ground paths should have low resistance and low inductance. It is also good practice to bypass the power supplies with quality capacitors. Apply low equivalent series resistance (ESR) 1  $\mu\text{F}$  to 10  $\mu\text{F}$  tantalum or electrolytic capacitors at the supplies to minimize any transient disturbance and to filter low frequency ripple. Figure 49 illustrates the basic supply bypassing configuration for the AD5121/AD5141.

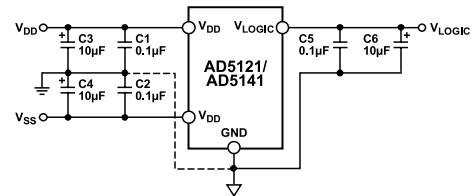
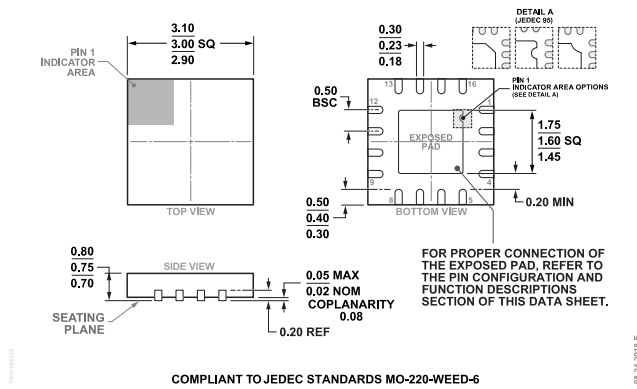


Figure 49. Power Supply Bypassing

OUTLINE DIMENSIONS



COMPLIANT TO JEDEC STANDARDS MO-220-WEED-6

**Figure 50. 16-Lead Lead Frame Chip Scale Package [LFCSP]  
3 mm x 3 mm Body and 0.75 mm Package Height  
(CP-16-22)  
Dimensions shown in millimeters**

Updated: March 16, 2022

ORDERING GUIDE

Model <sup>1,2</sup>	Temperature Range	Package Description	Packing Quantity	Package Option	Marking Code
AD5121BCPZ100-RL7	-40°C to +125°C	16-Lead LFCSP (3mm x 3mm w/ EP)	Reel, 1500	CP-16-22	DHF
AD5121BCPZ10-RL7	-40°C to +125°C	16-Lead LFCSP (3mm x 3mm w/ EP)	Reel, 1500	CP-16-22	DHE
AD5141BCPZ100-RL7	-40°C to +125°C	16-Lead LFCSP (3mm x 3mm w/ EP)	Reel, 1500	CP-16-22	DHD
AD5141BCPZ10-RL7	-40°C to +125°C	16-Lead LFCSP (3mm x 3mm w/ EP)	Reel, 1500	CP-16-22	DHC
AD5141WBCPZ10-RL7	-40°C to +125°C	16-Lead LFCSP (3mm x 3mm w/ EP)	Reel, 1500	CP-16-22	DN3

<sup>1</sup> Z = RoHS Compliant Part.

<sup>2</sup> W = Qualified for Automotive Applications.

R<sub>AB</sub> (KΩ), RESOLUTION, AND INTERFACE OPTIONS

Model <sup>1,2</sup>	R <sub>AB</sub>	Resolution	Interface
AD5121BCPZ100-RL7	100	128	SPI/I <sup>2</sup> C
AD5121BCPZ10-RL7	10	128	SPI/I <sup>2</sup> C
AD5141BCPZ100-RL7	100	256	SPI/I <sup>2</sup> C
AD5141BCPZ10-RL7	10	256	SPI/I <sup>2</sup> C
AD5141WBCPZ10-RL7	10	256	SPI/I <sup>2</sup> C

<sup>1</sup> Z = RoHS Compliant Part.

<sup>2</sup> W = Qualified for Automotive Applications.

EVALUATION BOARDS

Model <sup>1,2</sup>	Package Description
EVAL-AD5141DBZ	Evaluation Board

<sup>1</sup> The evaluation board is shipped with the 10 kΩ R<sub>AB</sub> resistor option. However, the board is compatible with all of the available resistor value options.

<sup>2</sup> Z = RoHS Compliant Part.

## OUTLINE DIMENSIONS

### AUTOMOTIVE PRODUCTS

The AD5121W/AD5141W model is available with controlled manufacturing to support the quality and reliability requirements of automotive applications. Note that this automotive model may have specifications that differ from the commercial models; therefore, designers should review the [Specifications](#) section of this data sheet carefully. Only the automotive grade products shown are available for use in automotive applications. Contact your local Analog Devices account representative for specific product ordering information and to obtain the specific Automotive Reliability reports for these models.

I<sup>2</sup>C refers to a communications protocol originally developed by Philips Semiconductors (now NXP Semiconductors)